



# ATECC608B-TNGTLS

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## ATECC608B-TNGTLS CryptoAuthentication™ Data Sheet

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### Introduction

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The ATECC608B-TNGTLS is a pre-provisioned variant of the ATECC608B. The ATECC608B provides enhanced security measures over that of the ATECC608A. These enhancements also apply to the ATECC608B-TNGTLS. The Trust&GO secure element is part of Microchip's family of generically provisioned security-focused devices. The device configuration was designed to make the secure element applicable to some of the most common use cases in the IoT market, while minimizing the learning and start-up curves associated with security devices.

This data sheet provides the slot and key configuration information that is unique to the ATECC608B-TNGTLS. This information clearly defines the access policies of each of the data zone slots. Only relevant command and I/O operating information has been included. An application section discussing Microchip's hardware and software tools that can aid in developing an application is also provided with additional links to the location of the tools.

### Features

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- Fully Specified Configuration Zone
- I<sup>2</sup>C Interface with One-Time Changeable I<sup>2</sup>C Address
- One Permanent Primary P-256 Elliptic Curve Cryptography (ECC secp256r1) Private Key Fixed at Manufacturing Time
- One Internal Sign Private Key for Key Attestation
- Three Secondary P-256 ECC Private Keys that Can Be Regenerated by the User
- Signer Public Key from Signer Certificate
- IO Protection Key Slot to Protect I<sup>2</sup>C Communication
- ECDH/KDF Key Slot Capable of Being Used with AES Keys and Commands
- X.509 Compressed Certificate Storage
- Available in 8-Pad UDFN and 8-Pin SOIC Packages in 2k or 100 unit production quantities.

### Use Cases

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- Secure IoT TLS 1.2 and 1.3 Connections

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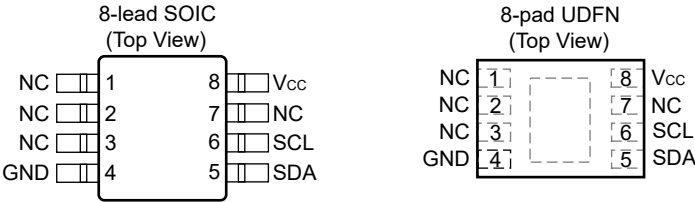
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1. Pin Configuration and Pinouts

Table 1-1. Pin Configuration

Pin	Function
NC	No Connect
GND	Ground
SDA	I <sup>2</sup> C Serial Data
SCL	I <sup>2</sup> C Serial Clock Input
V <sub>cc</sub>	Power Supply

Figure 1-1. UDFN and SOIC Pinout



**Note:** The UDFN backside paddle is recommended to be connected to GND.

## 2. EEPROM Memory and Data Zone Access Policies

The EEPROM memory contains a total of 1,400 bytes and is divided into the following zones:

**Table 2-1. ATECC608B-TNGTLS EEPROM Zones**

Zone	Description	Nomenclature
Configuration	<p>Zone of 128 bytes (1,024 bits) EEPROM that contains:</p> <ul style="list-style-type: none"> <li>• Device configuration</li> <li>• Slot access policy information</li> <li>• Counter values</li> <li>• Device serial number</li> <li>• Lock information</li> </ul> <p>The LockConfig byte has already been set. Nothing can be directly written to this zone. The zone can always be read.</p>	Config[a:b] = A range of bytes within a field of the Configuration zone
Data	<p>Zone of 1,208 bytes (9.7 Kb) split into 16 general purpose read-only or read/write memory slots. The access policy information defined by the Configuration zone bytes determines how each slot can be accessed. The Access Policy for each data slot in the ATECC608B-TNGTLS device has already been set and the slot Access Policies defined by the Configuration zone are in full effect. Some slots can be read from or written to while others cannot, depending upon that slot's Access Policy.</p>	Slot[YY] = The entire contents stored in Slot YY of the Data zone
One-Time-Programmable (OTP)	<p>Zone of 64 bytes (512 bits) arranged into two blocks of 32 bytes each. For the ATECC608B-TNGTLS, the zone is preloaded with a predefined value. This zone cannot be modified but can be read at any time. See Section <a href="#">2.3. ATECC608B-TNGTLS EEPROM One Time Programmable (OTP) Zone</a> for more information.</p>	OTP[bb] = A byte within the OTP zone, while OTP[aa:bb] indicates a range of bytes

**Table 2-2. Document Terms**

Terms discussed within this document will have the following meanings:

Term	Meaning
Block	A single 256-bit (32-byte) area of a particular memory zone. The industry standard SHA-256 documentation also uses the term block to indicate a 512-bit section of the message input. Within this document, this convention is used only when describing hash input messages.
KeyID	KeyID is equivalent to the slot number for those slots designated to hold key values. Key 1 (sometimes referred to as key[1]) is stored in Slot[1] and so on. While all 16 slots can potentially hold keys, those slots that are configured to permit clear text reads are not normally used as private or secret keys by the crypto commands.
mode[b]	Indicates bit, b, of the parameter mode.
SRAM	Contains input and output buffers, as well as internal state storage locations. This memory is not directly accessible by the user.
Word	A single 4-byte word of data read from or written to a block. The word is the smallest unit of data access.
LSB/MSB	Least Significant Byte/Most Significant Byte.
LSb/MSb	Least Significant Bit/Most Significant Bit.

### 2.1 ATECC608B-TNGTLS Configuration Zone

The ATECC608B-TNGTLS configuration is fixed and cannot be modified by the customer. Relevant information about how the device is configured is shown below or in the slot information.

#### Device Configuration Information

- The serial number for each device is unique and stored in bytes [0:3, 8:12]. Bytes [0:1] are 0x01 0x23 and byte [8] is 0x01. All other bytes are unique.
- The default 7-bit I<sup>2</sup>C address is 0x35. The I<sup>2</sup>C address can be overwritten using the `UpdateExtra` command.



**Important:** The default I<sup>2</sup>C address of the ECC608-TNGTLS differs from that of the standard ATECC608 Device.

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- The I/O levels are set to a fixed reference level; therefore, the host processor can operate at a lower voltage than the ATECC608B-TNGTLS device.
- The Watchdog Timer (WDT) is set to a maximum time-out of 1.3s.
- The use of an I/O protection key is enabled with the key stored in Slot 6.
- For the ATECC608B-TNGTLS, the following individual slots may be locked: Slots 2-4, 6 and slot 8.
- Monotonic counters are available for use by the system and are not attached to any keys.
- The Health Test Failure bit is cleared after any time that a command fails as a result of a health test failure. If the failure symptom is transient, the command may pass when run a second time.

#### 2.1.1 Modifiable Configuration Zone Bytes

No bytes within the Configuration Zone can be directly written because the Config Zone is already locked. Several bytes can still be modified through the use of other commands.

##### SlotLocked Bits

For the ATECC608B-TNGTLS, the following individual slots may be locked: Slots 2-4, 6 and slot 8. These can be locked through the SlotLock mode of the `Lock` command. Each slot where this feature is enabled can be individually locked just once. Once a slot has been locked, it can never be modified or unlocked but can still be used based on the Access Policies defined for that slot.

Bytes 88 and 89 store the SlotLocked bytes. Initially, all bits in these bytes are set to a value of one. For those slots that have been locked, the value of the respective bit will be set to a value of zero.

##### I<sup>2</sup>C Address Redefinition

This device configuration has been created such that the I<sup>2</sup>C address can be redefined one time. The `UpdateExtra` command can be used to rewrite byte 85 of the Configuration zone to a new I<sup>2</sup>C address. When this byte is set to a non-zero value, the device configuration uses byte 85 as its I<sup>2</sup>C address instead of the default address. Once this byte has been rewritten, the device must be powered-down or put into Sleep mode before this change takes effect.



**Important:** If there is no need to change the I<sup>2</sup>C address, this location must be written with the default I<sup>2</sup>C address.

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##### User Extra Byte

The UserExtra byte can be used for any desired purpose. This byte can be updated just once with the `UpdateExtra` command. The UserExtra byte is located at byte 84 of the Configuration zone.

### Counter[0,1]

While the counters are not used by this device, they are not disabled. If so desired, the monotonic counters may be used by the system. Note that the counters are initialized to zero and can count to the maximum value of 2,097,151. The counter value can be incremented or read through the use of the `Counter` command. How this counter is used is strictly up to the system and independent of anything else on the device. Counter values can be read or updated using the `Counter` command.

## 2.2 Data Zone and Access Policies

The following sections describe the detailed access policy information associated with each slot. The actual access policy information is stored within the Slot and Key configuration sections in the EEPROM Configuration zone. Each Data zone slot has two Slot Configuration bytes and two Key Configuration bytes associated with it. Together, these four bytes create the access policies for each slot. The actual type of data stored within the slot is determined by the access policies for that slot.

### 2.2.1 Data Zone Data Types

The following section provides more details on the various types of data capable of being stored in the ATECC608B-TNGTLS data slots.

#### 2.2.1.1 Private Keys

ECC private keys are the fundamental building blocks of ECC Security. These keys are private and unique to each device and can never be read. ECC private keys are randomly generated by the secure element's TRNG and are securely held in slots configured as ECC private keys.

##### Primary Private Key

This is the primary authentication key. It is permanent and cannot be changed. Each device has its own unique private key.

This key is enabled for two primary elliptic curve functions:

- ECDSA Sign for authentication
- ECDH for key agreement. If encryption of the ECDH output is required, the IO protection key needs to be first set up. See Section 2.2.1.5. [I/O Protection Key](#) for setup details.

This private key is the foundation for the generation of the corresponding public key and the X.509 Certificates.

##### Secondary Private Keys

There are additional private keys that can be used for future use cases, such as additional service authentication.

These keys are enabled for the following primary elliptic curve functions:

- ECDSA Sign for authentication.
- ECDH for key agreement. If encryption of the ECDH output is required, the IO protection key needs to be first set up. See Section 2.2.1.5. [I/O Protection Key](#) for setup details.
- GenKey for overwriting the slot with a new internally-generated random private key.

While the primary private key and certificates are permanent, these other keys can be overwritten with a new internally-generated private key (`GenKey` command mode = 0x04) to enable key deletion, key rotation and remote provisioning. The keys are also slot-lockable (`KeyConfig.Lockable` bit is set to zero), meaning the `Lock` command can be used in SlotLock mode to render the current key permanent and prevent it from being changed by the `GenKey` command. When performing key changes, [Key Attestation](#) is required to ensure to another system that the device's new public key being presented actually originated from the device in question.

##### Key Attestation

The private key in slot 1 is configured as an internal sign-only key, which means it can only sign messages generated internally by the `GenKey` or `GenDig` commands and cannot be used to sign arbitrary external messages. This feature allows the internal sign key to be used to attest to what keys are in the device and their configuration/status to any system that knows (and trusts) the internal sign public key.



### 2.2.1.2 Public Keys

Public keys are associated with ECC private keys. Every ECC private key will have its own unique public key. Public keys associated with private keys stored on the device can be retrieved by using the `GenKey` command. Public keys from an ECC private key stored off chip can be stored in the device in a slot configured for a public key.

### 2.2.1.3 Certificate Storage

The ATECC608B-TNGTLS storage is centered around securely holding keys. Since X.509 certificates tend to be larger than what will fit into a single ATECC608B-TNGTLS device slot, a compressed format is used. This technique may be better called a partial certificate as it stores dynamic certificate information on the device and imposes some limitations. Dynamic information is certificate content that can be expected to change from device to device (e.g., public key, validity dates, etc.). Firmware is expected to have a certificate definition (`atcacert_def_t` from `CryptoAuthLib`) with a template of the full X.509 certificate containing static information (data that are the same for all certificates) and instructions on how to rebuild the full certificate from the dynamic information in the compressed certificate.

The following application note documents the compressed certificate format: [ATECC Compressed Certificate Definition](#).

The [CryptoAuthLib library](#) also contains the `atcacert` module for working with compressed certificates.

#### Device Certificate

The device certificate consists of information associated with the actual end unit. For the ATECC608B-TNGTLS, the device certificate is stored in Slot #10. The IEEE MAC address is part of the device certificate as a Subject Alternative Name (SAN) serial number object. The MAC address data is stored in Slot #5 of the device as ASCII-hex and can be read in the clear directly from that slot, or can be read from the certificate by rebuilding the device certificate using `CryptoAuthLib`'s `atcacert` module and the Trust&GO certificate definition, which is also part of `CryptoAuthLib`.

#### Signer Certificate

The signer certificate consists of the information associated with the signer certificate authority used to sign the device certificate. For the ATECC608B-TNGTLS, the signer certificate is stored in Slot #12. The signer public key is also required to rebuild the full signer certificate.

#### Signer Public Key

The signer public key is the public key needed to verify the signer and the information that is associated with the signer compressed certificate. For the ATECC608B-TNGTLS, it is stored in Slot #11.

The following table shows all the slots associated with certificates in the ATECC608B-TNGTLS:

Slot	Description
0	Primary private key. The public key can be generated at any time using the <code>GenKey</code> command in Mode = 0x00.
5	MAC EUI-48 Address. Included as part of the device certificate.
10	Device certificate. This is stored here in a compressed format.
11	Signer public key.
12	Signer certificate. This is stored in a compressed format.

These certificates are also permanent and the slots they are stored in cannot be changed.

### 2.2.1.4 AES Key Storage

Commands such as `ECDH` and `KDF` output symmetric keys. These commands can optionally save those keys to a slot for secure storage and use as AES keys. The AES key storage slot has been set as a destination slot for those keys. Multiple AES keys are capable of being stored in a slot.

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### 2.2.1.5 I/O Protection Key

The `Verify`, `ECDH`, and `KDF` commands can optionally use the I/O protection feature to encrypt some parameters and validate (via MAC) some responses. This is to help protect against man-in-the-middle attacks on the physical I<sup>2</sup>C bus. However, before this feature can be used, the MCU and ATECC608B-TNGTLS need to generate and save a unique I/O protection key, essentially pairing the MCU and ATECC608B-TNGTLS devices to each other. The pairing process must happen on the first boot.

I/O protection key generation:

1. MCU uses a random command to generate a random 32-byte I/O protection key.
2. MCU saves the I/O protection key in its internal Flash.
3. MCU writes the I/O protection key to the I/O protection key slot.
4. MCU slot locks that slot to make the I/O protection key permanent.

As a pairing check, the MCU could use the `MAC` command to issue a challenge to the I/O protection key and verify that the I/O protection key stored in Flash matches the one in the ATECC608B-TNGTLS.

### 2.2.1.6 MAC Address

The IEEE MAC address is part of the device certificate as a Subject Alternative Name (SAN) serial number object. The MAC address adheres to the IEEE EUI-48 standard for MAC addresses. This address is a unique identifier for LAN, WiFi or Bluetooth networks. This value is programmed into the ATECC608B-TNGTLS during device provisioning. The MAC address is a 6 byte (48-bit) value. It is stored as ASCII Hex characters in the first 12 bytes of the data slot.

#### MAC EUI-48 Example

1. The EUI-48 value is represented as 6-bytes of hex separated by a dash.
2. The individual hex digits are interpreted as ASCII Characters
3. Each of these characters are then translated to their actual ASCII hexadecimal code. So a 6-byte hexadecimal value will convert to a 12-byte ASCII-Hex value. Note the conversion between the ASCII character and the ASCII code in both decimal and hexadecimal are shown in [Table 2-3](#).

**Table 2-3. Hex ASCII Conversion**

Hex / ASCII Char	ASCII Code		Hex / ASCII Char	ASCII Code	
	DEC	HEX		DEC	HEX
"0"	48	0x30	"8"	56	0x38
"1"	49	0x31	"9"	57	0x39
"2"	50	0x32	"A"	65	0x41
"3"	51	0x33	"B"	66	0x42
"4"	52	0x34	"C"	67	0x43
"5"	53	0x35	"D"	68	0x44
"6"	54	0x36	"E"	69	0x45
"7"	55	0x37	"F"	70	0x46

**Table 2-4. MAC EUI-48 Example (34-C8-CE-AD-21-60)**

	Byte 0		Byte 1		Byte 2		Byte 3		Byte 4		Byte 5	
ASCII Char	3	4	C	8	C	E	A	D	2	1	6	0
ASCII Code(DEC) <sup>(1)</sup>	51	52	67	56	67	69	65	68	50	49	54	48
ASCII Code(HEX) <sup>(1)</sup>	33	34	43	38	43	45	41	44	32	31	36	30

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**Note:** (1) This is the actual 12-byte value stored in the data slot that represents the MAC IEEE EUI-48 Identifier.

### 2.2.1.7 General Data Storage

A number of slots have been set up to support general public data storage. These slots may be used to store any data that are allowed to be publicly accessible. These slots can always be read and written in the clear.

### 2.2.2 Slot Configuration Terminology

The following section provides a set of terms used to discuss configuration options. The terms are arranged alphabetically.

Term	Description
<b>AES Key</b>	Slot can be used as a key source for AES commands. The AES key is 128 bits in width for the ATECC608B-TNGTLS.
<b>Always Write</b>	Slot can be written in the clear with the <code>Write</code> command.
<b>Clear Read</b>	Slot is considered public (non-secret) and its contents can be read in the clear with the <code>Read</code> command.
<b>ECDH</b>	Elliptic Curve Diffie Hellman. Private key can be used with the <code>ECDH</code> command.
<b>Ext Sign</b>	Private key can be used to sign external (arbitrary) messages.
<b>Int Sign</b>	Private key can be used to sign internal messages generated by the <code>GenKey</code> or <code>GenDig</code> commands. Used to attest to the device's internal keys and configuration.
<b>Lockable</b>	Slot can be locked at some point in the future. Once locked, the slot contents cannot be changed (read/use only).
<b>No Read</b>	Slot is considered secret and its contents cannot be read with the <code>Read</code> command. Private keys and symmetric secrets must always be configured as No Read.
<b>No Write</b>	Slot cannot be changed with the <code>Write</code> command.
<b>Permanent</b>	Private key is permanent/unchangeable. It is internally generated during factory provisioning.
<b>Updatable</b>	Private key can be overwritten later with a new, random, internally-generated private key. Its initial value is internally generated during factory provisioning.

### 2.2.3 ATECC608B-TNGTLS Slot Configuration Summary

The ATECC608B-TNGTLS has 16 slots that are configured for different use cases. Below is a summary of those slots with their configuration and proposed uses for the ATECC608B-TNGTLS:

Slot	Use Case	Description	Primary Configuration
0	Primary private key	Primary authentication key.	Permanent, Ext Sign, ECDH
1	Internal sign private key	Private key that can only be used to attest to the internal keys and state of the device. It cannot be used to sign arbitrary messages.	Permanent, Int Sign
2	Secondary private key 1	Secondary private key for other uses.	Updatable, Ext Sign, ECDH, Lockable
3	Secondary private key 2	Secondary private key for other uses.	Updatable, Ext Sign, ECDH, Lockable
4	Secondary private key 3	Secondary private key for other uses.	Updatable, Ext Sign, ECDH, Lockable
5	MAC Address	IEEE EUI-48 MAC Address	Permanent, Clear Text Read
6	IO protection key	Key used to protect the I <sup>2</sup> C bus communication (IO) of certain commands. Requires setup before use.	No read, Always write, Lockable

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## EEPROM Memory and Data Zone Access Policies

.....continued

Slot	Use Case	Description	Primary Configuration
7	Reserved	—	—
8	General data	General purpose data storage (416 bytes).	Clear read, Always write, Lockable
9	AES key	Intermediate key storage for ECDH and KDF output.	No read, Always write, AES key
10	Device compressed certificate	Certificate primary public key in the CryptoAuthentication™ compressed format.	Clear read, No write
11	Signer public key	Public key for the CA (signer) that signed the device cert.	Clear read, No write
12	Signer compressed certificate	Certificate for the CA (signer) certificate for the device certificate in the CryptoAuthentication™ compressed format.	Clear read, No write
13	Reserved	—	—
14	Reserved	—	—
15	Reserved	—	—

### 2.2.4 ATECC608B-TNGTLS Detailed Slot Access Policies

#### Detailed Slot Configurations

The following tables provide a more detailed description of the slot configuration and key configuration settings for each configured slot on the device. Relevant commands and command modes applicable to each configured slot are included.

**Table 2-5. Slot 0 Configuration Information**

Slot	Configuration Value	Description of Enabled Features
0	Key:	<b>Primary Private Key</b> <ul style="list-style-type: none"> <li>Contains P256 NIST ECC private key</li> <li>The corresponding public key can always be generated</li> <li>Random nonce is required</li> </ul>
	Slot:	<ul style="list-style-type: none"> <li>Slot is secret</li> <li>Can sign external messages</li> <li>Can use with ECDH command</li> </ul>

**Table 2-6. Slot 1 Configuration Information**

Slot	Configuration Value	Description of Enabled Features
1	Key:	<b>Internal Sign Private Key</b> <ul style="list-style-type: none"> <li>Contains P256 NIST ECC private key</li> <li>The corresponding public key can always be generated</li> <li>Random nonce is required</li> </ul>
	Slot:	<ul style="list-style-type: none"> <li>Slot is secret</li> <li>Can sign internal messages generated by GenDig or GenKey</li> <li>ECDH disabled</li> </ul>

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**Table 2-7. Slot and Key Configuration Slots 2-4**

Slot	Configuration Value	Description of Enabled Features
2,3 or 4	Key:	<b>Secondary Private Keys 1-3</b> <ul style="list-style-type: none"> <li>• Contains P256 NIST ECC private key</li> <li>• The corresponding public key can always be generated</li> <li>• Random nonce is required</li> <li>• This slot can be individually locked</li> </ul>
	Slot:	<ul style="list-style-type: none"> <li>• GenKey can be used to generate a new ECC private key in this slot prior to locking</li> <li>• Slot is secret</li> <li>• Can sign external messages</li> <li>• Can use with <code>ECDH</code> command</li> </ul>

**Table 2-8. Slot 5 Configuration Information**

Slot	Configuration Value	Description of Enabled Features
5	Key:	<b>Clear Text Data</b>
	Slot:	<ul style="list-style-type: none"> <li>• Can not be written</li> <li>• Can be read as clear text</li> </ul>

**Table 2-9. Slot 6 Configuration Information**

Slot	Configuration Value	Description of Enabled Features
6	Key:	<b>IO Protection Key</b> <ul style="list-style-type: none"> <li>• Can contain a SHA256 symmetric key or other data. If the IO protection key is not used, this slot can be used for other data</li> <li>• A random nonce is required when this key is used</li> <li>• This slot can be individually locked</li> </ul>
	Slot:	<ul style="list-style-type: none"> <li>• Data can be written in the Clear</li> <li>• The contents of this slot are secret and cannot be read</li> <li>• Slot cannot be used for the <code>CheckMac Copy</code> command</li> </ul>

**Table 2-10. Slot 8 Configuration Information**

Slot	Configuration Value	Description of Enabled Features
8	Key:	<b>General Data</b> <ul style="list-style-type: none"> <li>• This slot is designated for use with general data</li> <li>• Slot is lockable</li> </ul>
	Slot:	<ul style="list-style-type: none"> <li>• Clear text writes and reads are permitted to this slot</li> <li>• Slot cannot be used for the <code>CheckMac Copy</code> command</li> </ul>

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## EEPROM Memory and Data Zone Access Policies

**Table 2-11. Slot 9 Configuration Information**

Slot	Configuration Value	Description of Enabled Features
9	Key:	<b>AES Key</b> <ul style="list-style-type: none"> <li>Slot can store up to four AES 128-bit symmetric keys</li> </ul>
	Slot:	<ul style="list-style-type: none"> <li>Clear text writes are allowed to this slot</li> <li>This slot is secret</li> <li>Slot cannot be used for the <code>CheckMac Copy</code> command</li> </ul>

**Table 2-12. Slot 10 Configuration Information**

Slot	Configuration Value	Description of Enabled Features
10	Key:	<b>Device Compressed Certificate</b> <ul style="list-style-type: none"> <li>Slot defined to store other data</li> </ul>
	Slot:	<ul style="list-style-type: none"> <li>Data cannot be overwritten</li> <li>Data can be read in the clear</li> </ul>

**Table 2-13. Slot 11 Configuration Information**

Slot	Configuration Value	Description of Enabled Features
11	Key:	<b>Signer Public Key</b> <ul style="list-style-type: none"> <li>Slot is defined for ECC key</li> <li>ECC key is a public key</li> </ul>
	Slot:	<ul style="list-style-type: none"> <li>Data cannot be overwritten</li> <li>Data can be read in the clear</li> </ul>

**Table 2-14. Slot 12 Configuration Information**

Slot	Configuration Value	Description of Enabled Features
12	Key:	<b>Signer Compressed Certificate</b> <ul style="list-style-type: none"> <li>Slot defined to store other data</li> </ul>
	Slot:	<ul style="list-style-type: none"> <li>Data cannot be overwritten</li> <li>Data can be read in the clear</li> </ul>

### 2.3 ATECC608B-TNGTLS EEPROM One Time Programmable (OTP) Zone

The OTP zone of 64 bytes (512 bits) is part of the EEPROM array and is used for read-only storage. It is organized as two blocks of 32 bytes each. For the ATECC608B-TNGTLS, the OTP zone is shipped pre-locked and contains the following information:

```
78 36 74 6A 75 5A 4D 79 00 00 00 00 00 00 00 00
00 00 00 00 00 00 00 00 00 00 00 00 00 00 00 00
00 00 00 00 00 00 00 00 00 00 00 00 00 00 00 00
00 00 00 00 00 00 00 00 00 00 00 00 00 00 00 00
```

The data byte values written into the OTP zone are always available for reading using either 4- or 32-byte reads but can never be modified.

# ATECC608B-TNGTLS

## EEPROM Memory and Data Zone Access Policies

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**CAUTION**

**Notice:** The bytes in the OTP zone may change over time. These values should not be used in any cryptographic calculations.

---

### 3. Static RAM (SRAM) Memory

The device also includes an SRAM array that is used to store the input command or output result, nonces, intermediate computation values, ephemeral keys, the SHA context, etc. The contents of the SRAM can never be read directly; only used internally by the secure element. The entire contents of this memory are invalidated whenever the device goes into Sleep mode or the power is removed.

The SRAM Array consists of the following buffers:

#### TempKey

TempKey is the primary storage register in the SRAM array that can be used to store various intermediate values generated by various commands. TempKey is 64 bytes long and is divided into an upper and lower half. The contents of this register can never be read from the device (although the device itself can read and use the contents internally).

#### Message Digest Buffer

The Message Digest Buffer is a 64-byte register that is used to convey the input message digest to the `Verify` and `Sign` commands when the TempKey register is needed to retain different information. The `SHA` command can write a digest directly to this register to simplify external host programming.

#### Alternate Key Buffer

The Alternate Key Buffer is a 32-byte register that can be used by the `KDF` command to store keys when the TempKey register is needed to retain different information. It can be written to a fixed input value by the `Nonce` command or to a secret value by the `KDF` command.

#### SHA Context Buffer

The SHA context buffer allows for the generation of a digest to be interrupted to do other functions or to generate other digests. The `SHA` command uses a standard three-phase flow: Initialize, Update and Finalize. In many situations, the Update phase is run many times. Internal SRAM memory is used to store the intermediate state, aka SHA context, between these phases.



## 4. General Command Information

The following sections provide some general information on the basic I/O transactions, command structure, error codes, memory addressing and formatting of keys and signatures that are used in the ATECC608B-TNGTLS.

### 4.1 I/O Transactions

The ATECC608B-TNGTLS uses the I<sup>2</sup>C protocol to communicate with a host microcontroller. Security commands are sent to the device and responses are received from the device within a transaction that is constructed in the following way:

**Table 4-1. I/O Transaction Format**

Byte	Name	Meaning
0	Count	Number of bytes to be transferred to (or from) the device in the group, including the count byte, packet bytes and checksum bytes. Therefore, the count byte must always have a value of (N+1), where N is equal to the number of bytes in the packet plus the two checksum bytes. For a group with one count byte, 50 packet bytes and two checksum bytes, the count byte must be set to 53. The maximum size group (and value of count) is 155 bytes and the minimum size group is four bytes. Values outside this range will cause the device to return an I/O error.
1 to (N-2)	Packet	Command, parameters and data or response. See <a href="#">4.2. Command Packets</a> for general command packet information or <a href="#">5. Device Commands</a> for specific parameters for each command.
N-1, N	Checksum	CRC-16 verification of the count and packet bytes. The CRC polynomial is 0x8005. Prior to the start of the CRC calculation, the CRC register is initialized to zero. After the last bit of the count and packet is transmitted, the internal CRC register must have a value that matches the checksum bytes in the block. The first CRC byte transmitted (N-1) is the LSB of the CRC value, so the last byte of the group is the MSB of the CRC.

The ATECC608B-TNGTLS is designed to have the count value in the input group consistent with the size requirements that are specified in the command parameters. If the count value is inconsistent with the command opcode and/or parameters within the packet, the ATECC608B-TNGTLS responds in different ways depending upon the specific command. The response may either include an error indication or some input bytes may be silently ignored.

### 4.2 Command Packets

The command packet is broken down as shown in [Table 4-2](#):

**Table 4-2. Command Packets**

Byte	Name	Meaning
0	Opcode	The command code. See <a href="#">5. Device Commands</a> .
1	Param1	The first parameter; always present.
2-3	Param2	The second parameter; always present.
0-155	Data	Optional remaining input data.

After the ATECC608B-TNGTLS receives all the bytes in a group, the device transitions to the Busy state and attempts to execute the command. Neither status nor results can be read from the device when it is busy. During this time, the I/O interface of the device ignores all transitions on the I<sup>2</sup>C SDA input signal.

### 4.3 Status/Error Codes

The device does not have a dedicated STATUS register, so the output FIFO is shared among status, error and command results. All outputs from the device are returned to the system as complete groups which are formatted identically to input groups:

- Count
- Packet
- Two byte CRC

After the device receives the first byte of an input command group, the system cannot read anything from the device until the system sends all the bytes to the device.

After the wake and execution of a command, there will be error, status or result bytes in the device's output register that can be retrieved by the system. For a four bytes length of that group, the codes returned are detailed in [Table 4-3](#). Some commands return more than four bytes when they execute successfully. The resulting packet description is listed in [5. Device Commands](#).

CRC errors are always returned before any other type of error. They indicate that an I/O error occurred and that the command may be resent to the device. No particular precedence is enforced among the remaining errors if more than one occurs.

**Table 4-3. Status/Error Codes in Four Byte Groups**

State Description	Error/ Status	Description
Successful Command Execution	0x00	Command executed successfully.
CheckMac or Verify Miscompare	0x01	The <code>CheckMac</code> or <code>Verify</code> command was properly sent to the device, but the input response did not match the expected value.
Parse Error	0x03	Command was properly received but the length, command opcode or parameters are illegal regardless of the state (volatile and/or EEPROM configuration) of the ATECC608B-TNGTLS. Changes in the value of the command bits must be made before it is re-attempted.
ECC Fault	0x05	A computation error occurred during ECC processing that caused the result to be invalid. Retrying the command may result in a successful execution.
Self Test Error	0x07	There was a Self Test error and the chip is in Failure mode waiting for the failure to be cleared.
Health Test Error	0x08	There was a random number generator Health Test error and the chip fails subsequent commands requiring a random number until it is cleared.
Execution Error	0x0F	Command was properly received but could not be executed by the device in its current state. Changes in the device state or the value of the command bits must be made before it is re-attempted.
After Wake, Prior to First Command	0x11	Indication that the ATECC608B-TNGTLS has received a proper Wake token.
Watchdog About to Expire	0xEE	There is insufficient time to execute the given command before the WDT expires. The system must reset the WDT by entering the Idle or Sleep modes.
CRC or other Communications Error	0xFF	Command was not properly received by the ATECC608B-TNGTLS and must be retransmitted by the I/O driver in the system. No attempt was made to parse or execute the command.

### 4.4 Address Encoding

The following subsections provide detailed information on how to address the various memory zones of the ATECC608B-TNGTLS device.

#### 4.4.1 Configuration Zone Addressing

The Configuration zone can be accessed either 4 or 32 bytes at a time. Individual bytes cannot be accessed. The Configuration zone address is a 2-byte (16-bit value). Only the lowest five bits of the address word are used in addressing of the Configuration zone. For the ATECC608B-TNGTLS device, these addresses can only be used with the read command.

**Table 4-4. Address Format**

Byte 1: Addr[15:8]		Byte 0: Addr[7:0]	
Unused		Unused	Block
Offset		Offset	
Addr[15:8]		Addr[7:5]	Addr[4:3]
			Addr[2:0]

**Table 4-5. Configuration Zone Addresses**

Block # (Addr[4:3])	Offset Value (Addr[2:0])							
	000	001	010	011	100	101	110	111
00	[0:3]	[4:7]	[8:11]	[12:15]	[16:19]	[20:23]	[24:27]	[28:31]
01	[32:35]	[36:39]	[40:43]	[44:47]	[48:51]	[52:55]	[56:59]	[60:63]
10	[64:67]	[68:71]	[72:75]	[76:79]	[80:83]	[84:87]	[88:91]	[92:95]
11	[96:99]	[100:103]	[104:107]	[108:111]	[112:115]	[116:119]	[120:123]	[124:127]

#### 4.4.2 OTP Zone Addressing

The OTP zone can be accessed either 4 or 32 bytes at a time. The zone has a total of 64 bytes. Individual bytes cannot be accessed. The OTP zone address is a 2-byte (16-bit value). Only the lowest four bits are used in addressing.

For the ATECC608B-TNGTLS device, these addresses can only be used with the read command.

**Table 4-6. Address Format**

Byte 1: Addr[15:8]		Byte 0: Addr[7:0]	
Unused		Unused	Block
Offset		Offset	
Addr[15:8]		Addr[7:4]	Addr[3]
			Addr[2:0]

**Table 4-7. OTP Zone Byte Addresses**

Block # (Addr[3])	Block Offset Value (Addr[2:0])							
	000	001	010	011	100	101	110	111
0	[0:3]	[4:7]	[8:11]	[12:15]	[16:19]	[20:23]	[24:27]	[28:31]
1	[32:35]	[36:39]	[40:43]	[44:47]	[48:51]	[52:55]	[56:59]	[60:63]

#### 4.4.3 Data Zone Addressing

Read/Write access to the Data zone is much more complex than the Configuration and OTP zones. There are 16 slots and the size of the slots vary. Each slot's access policies individually control whether or not a slot has the ability to be read or written.

For the ATECC608B-TNGTLS:

- Data Slots 6, 8-9 can be written as clear text.
- No Data Slots can be written with encrypted text.
- Data Slots 8 and 10-12 can be read as clear text.
- Any slots not specified cannot be read or written.

**Table 4-8. Address Format by Data Slot Size**

Data Zone	Byte 1: Addr[15:8]		Byte 0: Addr[7:0]		
	Unused	Block	Unused	Slot	Offset
Data Slots[7:0]	Addr[15:9]	Addr[8]	Addr[7]	Addr[6:3]	Addr[2:0]
Data Slot[8]	Addr[15:12]	Addr[11:8]	Addr[7]	Addr[6:3]	Addr[2:0]
Data Slots[15:9]	Addr[15:10]	Addr[9:8]	Addr[7]	Addr[6:3]	Addr[2:0]

### Data Slots[7:0]

To fully access one of these slots, require two 32-byte accesses or nine 4-byte accesses.

**Table 4-9. Data Zone Addresses Slots 0-7**

Slot# (Addr[6:3])	Block # (Addr[8])	Block Offset Value (Addr[2:0])							
		000	001	010	011	100	101	110	111
0x0 to 0x7	00	[0:3]	[4:7]	[8:11]	[12:15]	[16:19]	[20:23]	[24:27]	[28:31]
	01	[32:35]	Not Valid	Not Valid	Not Valid	Not Valid	Not Valid	Not Valid	Not Valid

### Data Slot[8]

To fully access this slot, require thirteen 32-byte accesses or 104 4-byte accesses or a combination of the two methods.

**Table 4-10. Data Zone Addressing Slot 8**

Slot# (Addr[6:3])	Block # (Addr[8])	Block Offset Value (Addr[2:0])							
		000	001	010	011	100	101	110	111
0x8	0x0	[0:3]	[4:7]	[8:11]	[12:15]	[16:19]	[20:23]	[24:27]	[28:31]
	0x1	[32:35]	[36:39]	[40:43]	[44:47]	[48:51]	[52:55]	[56:59]	[60:63]
	...	...	...	...	...	...	...	...	...
	0xC	[384:387]	[388:391]	[392:395]	[396:399]	[400:403]	[404:407]	[408:411]	[412:415]

### Data Slots[15:9]

To fully access these slots, require three 32-byte accesses or eighteen 4-byte accesses or a combination of the two methods.

**Table 4-11. Data Zone Addressing Slots 9-15**

Slot# (Addr[6:3])	Block # (Addr[8])	Block Offset Value (Addr[2:0])							
		000	001	010	011	100	101	110	111
0x9 to 0xF	00	[0:3]	[4:7]	[8:11]	[12:15]	[16:19]	[20:23]	[24:27]	[28:31]
	01	[32:35]	[36:39]	[40:43]	[44:47]	[48:51]	[52:55]	[56:59]	[60:63]
	10	[64:67]	[68:71]	Not Valid	Not Valid	Not Valid	Not Valid	Not Valid	Not Valid

## 4.5 Formatting of Keys, Signatures and Certificates

The following sections provide detailed formatting information for ECC keys, Signatures and Compressed certificates.

### 4.5.1 ECC Key Formatting

The format for public and private keys depends on the command and key length. In general, the Most Significant Bytes (MSB) appear first on the bus and at the lowest address in memory. In the remainder of this section below, the bytes on the left side of the page are the MSBs. Microchip recommends all pad bytes be set to zero for consistency.

- ECC private keys appear to the user only as the input parameter to the `PrivWrite` command. This parameter is always 36 bytes in length and the first four bytes (32 bits) are all pad bits. ECC public keys appear as the input or output parameters to several commands, and they can also be stored in EEPROM. They are composed of an X value first on the bus or in memory, followed by a Y value. They are formatted differently depending on the situation as noted below:
- The public key is an output of the `GenKey` command or an input to the `Verify` command:**  
32 bytes of X, then 32 bytes of Y. (36 bytes) There are no pad bytes.
- Write command:**  
Public keys can be written directly to the EEPROM using the `Write` command and are always 72 bytes long, formatted as follows: 4-pad bytes, 32 bytes of X, four pad bytes, then 32 bytes of Y.
- GenKey command:**  
SHA Message: Public keys can be hashed and placed in `TempKey` by the `GenKey` command. The SHA message contains various bytes that are independent of the size of the key. These are followed by 25 bytes of pad, followed by 32 bytes of X, then by 32 bytes of Y.
- Verify command:**  
SHA Message: When used to validate a stored public key, the `Verify` command expects an input signature created over a SHA-256 digest of a key stored in memory. Such an inner SHA calculation is always performed over 72 bytes formatted as they are stored in EEPROM as 4-pad bytes, 32 bytes of X, 4-pad bytes, then 32 bytes of Y.

When a public key is configured to be validated by the `Verify` command, the Most Significant four bits of the first byte in memory are used internally by the device to save the validation state. They are always set to the invalid state (0xA) by the `Write` command, and then may be set to the Valid state (0x5) by the `Verify` command.

The lowest levels of the I/O protocols are described below. Above the I/O protocol level, the exact same bytes are transferred to and from the device to implement the commands. Error codes are documented in the following sections.

#### 4.5.1.1 Public Key Formats

The ATECC608B-TNGTLS works with the P-256 elliptic curve public keys in two formats. The following example illustrates those two formats in detail.

For the following examples, we'll use a sample public key, with the X and Y integers expressed as fixed-width big-endian unsigned integers:

```
X: b2be345ad7899383a9aab4fb968b1c7835cb2cd42c7e97c26f85df8e201f3be8
Y: a82983f0a11d6ff31d66ce9932466f0f2cca21ef96bec9ce235b3d87b0f8fa9e
```

### Command Public Key Format

Any command that returns a public key (*GenKey*) or accepts a public key as a parameter (*Verify* and *ECDH*) will format the public key as the X and Y big-endian unsigned integers concatenated together for a total of 64 bytes.

For example:

```
b2be345ad7899383a9aab4fb968b1c7835cb2cd42c7e97c26f85df8e201f3be8  
a82983f0a11d6ff31d66ce9932466f0f2cca21ef96bec9ce235b3d87b0f8fa9e
```

### Stored Public Key Format

When storing a public key in a slot for use with the *Verify* command, , the X and Y integers will be padded out to 36 bytes and concatenated together for a total of 72 bytes.

For example:

```
00000000b2be345ad7899383a9aab4fb968b1c7835cb2cd42c7e97c26f85df8e201f3be8  
00000000a82983f0a11d6ff31d66ce9932466f0f2cca21ef96bec9ce235b3d87b0f8fa9e
```

**Note:** Only Slots 8-15 are large enough to hold a public key.

### Stored Validated Public Key Format

A validated or invalidated public key format is the same as a stored public key format with the exception of the four Most Significant bits of the LSB. If a key is validated, the Least Significant Nibble will be 0x5 and 0xA if invalidated. These values can be changed by the *Verify* command in *Validate* or *Invalidate* mode. When written, the key will be initially invalidated.

Validated Public Key Example:

```
50000000b2be345ad7899383a9aab4fb968b1c7835cb2cd42c7e97c26f85df8e201f3be8  
00000000a82983f0a11d6ff31d66ce9932466f0f2cca21ef96bec9ce235b3d87b0f8fa9e
```

Invalidated Public Key Example:

```
A0000000b2be345ad7899383a9aab4fb968b1c7835cb2cd42c7e97c26f85df8e201f3be8  
00000000a82983f0a11d6ff31d66ce9932466f0f2cca21ef96bec9ce235b3d87b0f8fa9e
```

**Note:** Only Slots 8-15 are large enough to hold a public key.

## 4.5.2 Signature Format

The ECDSA signature that is generated and output by the *Sign* command or input to the *Verify* command is always 64 bytes in length. The signature is divided into R and S components. Both components are 32 bytes in length and R always appears before S on the bus. Each portion of the signature appears MSB first on the bus, meaning the MSB of the signature is in the lowest memory location.

### Example R/S Signature

Any command that returns a signature (*Sign*) or accepts a signature as a parameter (*Verify*) will format the signature as the R and S big-endian unsigned integers concatenated together for a total of 64 bytes.

For example:

```
R: 7337887F8C39DF79FD8BF88DDFBFB9DB15D7B1AD68196AE3FB0CE5BFA2842DF3  
S: 72868A43A42831E950E1DA9F73B29F5C0ED8A96B2889E3CBBE8E61EA6C67F673
```

## 4.5.3 Certificate Storage

The amount of storage required for a full X.509 Certificate within the device can rapidly use up multiple EEPROM memory slots. Depending on the actual application, it may or may not be desirable to use these slots for certificate storage. Due to these memory limitations, Microchip has defined an encoding that allows for a full X.509 Certificate to be reconstructed from a minimal amount of information.

The host system would actually be responsible for reconstructing the full X.509 Certificate but how to do this will be determined by the data stored in the encoded certificate. Data that are common to all devices for a given system can readily be stored in the host system. Other data can readily be calculated or extracted from data that are already stored in the device. [Table 4-12](#) indicates the type of data that are stored in an X.509 Certificate and how it can be encoded to fit into a single 72-byte slot.

**Table 4-12. Certificate Storage**

X.509 Certificate		Encoded Certificate		
X.509 Element	Size (Bytes)	Encoded Certificate Element	Device Cert (Bits)	Signer Cert (Bits)
Serial Number	8-20	Serial number source	4	4
Issue Date	13	Compressed format	19	19
Expiry Date	13	# of years before expiration	5	5
Signer ID <sup>2</sup>	4	ID of the specific signer used to sign the certificate (device cert) or of the signer itself (signer cert)	16	16
AuthorityKeyIdentifier	20	SHA1 HASH of the authority public key	0	0
SubjectKeyIdentifier	20	SHA1 HASH of the subject public key	0	0
Signature R	32	Stored in device	256	256
Signature S	32	Stored in device	256	256
Public Key X <sup>1</sup>	32	Calculated from the private key or stored in the device <sup>1</sup>	0	256
Public Key Y <sup>1</sup>	32	Calculated from the private key or stored in the device <sup>1</sup>	0	256
n/a	0	Cert format	4	4
n/a	0	Template ID	4	4
n/a	0	Chain ID	4	4
n/a	0	Reserved/User Defined	8	8
Total	(206-218 bytes)	—	576 bits (72 bytes)	1088 bits (136 bytes)

**Notes:**

1. For the device certificate, the device public key can be regenerated from the private key. For the signer certificate, the public key is typically stored in a separate slot.
2. For the device certificate, the ID of the signer used to sign the certificate is stored. For the signer certificate, the actual ID of the signer is stored so that the device can identify it.

Slot 8 contains a total of 416 bytes. Depending on the size of the serial number stored in the cert, it may or may not be possible to store two complete certificates. Often within devices where a chain of trust has been created, the device certificate, the signer certificate and the signer public key must be stored within the device.

For more information, see the [Compressed Certificate Definition](#) Application Note.

## 5. Device Commands

The following section details all of the commands broken out by Command mode that are allowed in the ATECC608B-TNGTLS. The commands have been broken into three categories:

### 1. General Device Commands

These commands fall into two categories:

- General device access commands that are used to send data to the device or retrieve data but typically do not perform any cryptographic functions.
- General cryptographic commands that can be used by the device or the system but typically do not operate on specific data slots.

### 2. Asymmetric Cryptography Commands

These commands perform asymmetric cryptographic operations, such as key generation, message signing and message verification that utilize an ECC public or private key. These commands are limited to use on ECC Data zone slots.

### 3. Symmetric Cryptography Commands

These commands perform a symmetric cryptographic function, such as generating a digest or MAC, key derivation or AES encryption and decryption.

### Input Parameters for all Commands

Multibyte input parameters are shown as big-endian (MSB first) values in the input parameters tables unless otherwise specified. Note that the ATECC608B-TNGTLS device actually expects the data to be sent little-endian (LSB first).

**Table 5-1. Commands, Descriptions and Command Categories**

Command	Description	Command Category
AES	Execute the AES-ECB Encrypt or Decrypt functions. Calculate a Galois Field Multiply.	Symmetric Cryptography Command
CheckMac	Verify a MAC calculated on another CryptoAuthentication™ device.	Symmetric Cryptography Command
Counter	Read or increment one of the monotonic counters	General Device Commands
ECDH	Generate an ECDH pre-master secret using stored private key and input public key.	Asymmetric Cryptography Command
GenDig	Generate a data digest from a random or input seed and a stored value.	Symmetric Cryptography Command
GenKey	Generate an ECC public key. Optionally generate an ECC private key.	Asymmetric Cryptography Command
Info	Return device state information.	General Device Commands
KDF	Implement the PRF or HKDF key derivation functions	Symmetric Cryptography Command
Lock	Prevent further modifications to a zone or slot of the device.	General Device Commands
MAC	Calculate digest (response) from key and other internal data using SHA-256.	Symmetric Cryptography Command
Nonce	Generate a 32-byte random number and an internally stored Nonce.	General Device Commands
Random	Generate a random number.	General Device Commands
Read	Read 4 or 32 bytes from the device, with or without authentication and encryption.	General Device Commands



.....continued		
Command	Description	Command Category
SelfTest	Test the various internal cryptographic computation elements	General Device Commands
Sign	ECDSA signature calculation.	Asymmetric Cryptography Command
SHA	Compute a SHA-256 or HMAC digest for general purpose use by the system.	General Device Commands
UpdateExtra	Update bytes 84 or 85 within the Configuration zone after the Configuration zone is locked.	General Device Commands
Verify	ECDSA verify calculation.	Asymmetric Cryptography Command
Write	Write 4 or 32 bytes to the device, with or without authentication and encryption.	General Device Commands

## 5.1 General Device Commands

The following table provides a summary of the general device commands:

**Table 5-2. General Device Commands**

Command Name	Description
Counter	Increments and reads the monotonic counters
Info	Used to read revision and status information from the device
Lock	Used to lock the individual lockable slots in the device
Nonce	Used to generate or pass a number used once into the device
Random	Used to generate a 32-byte random number used by the system
Read	Used to read various zones of the device
SelfTest	Tests the various internal cryptographic computation elements
SHA	Computes a SHA-256 or HMAC digest for general purpose use by the system
UpdateExtra	Updates bytes 84 or 85 within the Configuration zone after the Configuration zone is locked
Write	Used to write 4 or 32 bytes to the device, with or without authentication and encryption

### 5.1.1 Counter Command

The `Counter` command reads the binary count value from one of the two monotonic counters located on the device within the Configuration zone. The maximum value that the counter may have is 2,097,151. Any attempt to count beyond this value will result in an error code. The counter is designed to never lose counts even if the power is interrupted during the counting operation. In some power loss conditions, the counter may increment by a value of more than one.

For the ATECC608B-TNGTLS, the counters are not attached to any keys but may still be used by the system. Each count is set to its default value and can count to the maximum value.

### 5.1.2 Info Command

The `Info` command is used to read the status and state of the device. This information is useful in determining errors or to operate various commands.

### 5.1.3 Lock Command

For the ATECC608B-TNGTLS, the Configuration zone has already been locked and the access policies of the Data zone have already been enforced. However, several of the data slots can still be updated through the use of other commands. If so desired, some of these slots can be permanently locked from future updates by using the Slot Locking mode of the `Lock` command.

### 5.1.4 Nonce Command

The `Nonce` command generates a nonce (number used once) for use by a subsequent command by combining a random number (which can be generated internally or externally) with an input value from the system. The resulting nonce is stored internally in three possible buffers: TempKey, Message Digest Buffer and Alternate Key Buffer. Instead of generating a nonce, a value may be passed to the device if so desired.

### 5.1.5 Random Command

The `Random` command generates a random number to be used by the system. Random numbers are generated via the internal NIST 800-90 A/B/C random number generator. The output of the command is always a 32-byte number placed on the bus. The number cannot be stored in any data slot or SRAM location.

### 5.1.6 Read Command

The `Read` command can be used to access any of the EEPROM zones of the ATECC608B-TNGTLS device. Data zone access is limited based on the access policies set for each of the slots. Encrypted reads are possible only on the Data zone slots if specific access policies are set.

### 5.1.7 SelfTest Command

The `SelfTest` command performs a test of one or more of the cryptographic engines within the ATECC608B-TNGTLS chip. Some or all of the algorithms will be tested depending on the Input mode parameter.

For the ATECC608B-TNGTLS device, the `SelfTest` command has been disabled from running automatically after a Power-up or Wake event. However, the command may be executed by the system if so desired. There is no requirement to run this test.

If any self test fails, whether called automatically on power-up, wake or via this command, the chip will enter a Failure state, where chip operation is limited. The stored Failure state is always cleared upon a wake or power cycle.

### 5.1.8 SHA Command

The `SHA` command computes a SHA-256 or HMAC/SHA digest for general purpose use by the host system. The SHA computation is performed in a special section of internal ATECC608B-TNGTLS memory (Context Buffer) that is not read nor written by any other commands. Any arbitrary command can be interspersed between the various phases of the `SHA` command without problems. This SHA context is invalidated on power-up and wake. In most cases, if an error occurs during the execution of the `SHA` command, the context is retained without change.

### 5.1.9 UpdateExtra Command

The `UpdateExtra` command is used to update the UpdateExtra and UpdateExtraAdd bytes, bytes 84 and 85 respectively, in the Configuration zone. These bytes can only be updated by this command. These bytes are one-time updatable bytes and can only be updated if the current value is 0x00. Trying to update this byte if the value is not 0x00 will result in an error.

For the ATECC608B-TNGTLS device, the UpdateExtraAdd byte (byte 85) has been configured to be an alternate I<sup>2</sup>C address.

### 5.1.10 Write Command

For the ATECC608B-TNGTLS, the Configuration zone and OTP zone have been locked and no updates to these zones are possible. Limited write capability exists on the Data zone based on access policies of each slot. Slots that can be written are described in the submodes of this command.

## 5.2 Asymmetric Cryptography Commands

The Asymmetric Cryptography command set is made up of those commands that are specifically used to generate or use ECC keys. Keys are typically stored in Data zone slots, but, for some commands, could also be in the SRAM array.

**Table 5-3. Asymmetric Cryptography Commands**

Command Name	Description
ECDH	Generates an ECDH pre-master secret using the stored private key and input public key
GenKey	Generates an ECC private key or optionally generates an ECC public key from the stored private key
Sign	Signs an internal or external message digest using an ECC private key with an ECDSA signature calculation
Verify	Verifies an internal or external message digest using an ECC public key with an ECDSA verify calculation

### 5.2.1 ECDH Command

The `ECDH` command is used to generate a shared secret between two devices. By passing an ECC public key from another device and combining it with the ECC private key stored in a slot or with an ephemeral key stored in `TempKey` and doing the reverse on the other device, both devices will generate the same shared pre-master secret. This can, then, be further combined with other common data in both sides to generate a shared session key between the devices. The `KDF` command is often used with TLS sessions to further diversify the shared secret.

### 5.2.2 GenKey Command

The `GenKey` command is used to generate ECC private keys, ECC public keys from private keys or generate a public key digest. This command is only applicable for those slots designated to be ECC private or public keys. Running this command on a non-ECC slot will result in an error.

### 5.2.3 Sign Command

The `Sign` command generates a signature using the ECDSA algorithm. The ECC private key in the slot specified by `KeyID` is used to generate the signature. Multiple modes of the device are available depending on what is being signed.

### 5.2.4 Verify Command

The `Verify` command takes an ECDSA [R,S] signature and verifies that it is correctly generated given an input message digest and public key. In all cases, the signature is an input to the command. The public key can be either stored on the device or provided as an input.

An optional MAC can be returned from the `Verify` command to defeat any man-in-the-middle attacks. If the verify calculation shows that the signature is correctly generated from the input digest, a MAC will be computed based on an input nonce stored in `TempKey` and the value of the I/O protection secret, which is stored in both the ATECC608B-TNGTLS and the host MCU. MAC outputs can only be generated in External and Stored modes. The I/O protection function must be enabled for MAC computation.

## 5.3 Symmetric Cryptography Commands

The Symmetric Cryptography command set is made up of those commands associated with the generation or use of Symmetric Keys. Keys are typically stored in Data zone slots, but for some commands could also be in the SRAM memory locations.

Table 5-4. Symmetric Cryptography Commands

Command Name	Description
AES	Execute the AES-ECB Encrypt or Decrypt functions. Calculate a Galois Field Multiply.
CheckMac	Verify a MAC calculated on another CryptoAuthentication™ device.
GenDig	Generate a data digest from a random or input seed and a stored value.
KDF	Implement the PRF or HKDF key derivation functions
MAC	Calculate digest (response) from key and other internal data using SHA-256.

### 5.3.1 AES Command

The AES Command can be used to encrypt and/or decrypt a 16-byte block of data utilizing an AES key. Note that the key is stored in a 16 Byte (128 bit) location with a given slot or within the first 16 bytes of TempKey. Multiple keys may be stored in a given slot and accessed in successive 16-byte boundaries, starting with 0-15 up to the size of the slot, but not exceeding four keys in any slot. For the ATECC608B-TNGTLS, an AES key may be stored in Slot 9. Slot 9 can accommodate up to four AES keys.

In addition to AES encryption and decryption, the AES command may be used to generate a Galois Field Multiply (GFM) in support of other cryptographic operations.

### 5.3.2 CheckMac Command

The CheckMac command calculates a MAC response that would have been generated on a different CryptoAuthentication™ (ATECC608B, ATECC508A, ATSHA204A) device and then compares the result with the input value. The command returns a boolean result to indicate the success or failure of the comparison.

If a value in TempKey is used as an input to the CheckMac, then a Nonce and/or GenDig command must be run prior to the CheckMac command.

### 5.3.3 GenDig Command

The GenDig command uses a SHA-256 hash to combine a stored or input value with the contents of TempKey, which must be validated prior to the execution of this command. The stored value can come from one of the data slots, the Configuration zone, either of the OTP pages or the monotonic counters. The specific mode of the device determines which data are to be included in the GenDig calculation.

In some cases, it is required to run the GenDig prior to the execution of some commands. The command can be run multiple times to include more data in the digest prior to executing a given command. The resulting digest is retained in TempKey and can be used in one of four ways:

1. It can be included as part of the message used by the MAC, Sign or CheckMac commands. Because the MAC response output incorporates both the data used in the GenDig calculation and the secret key from the MAC command, it serves to authenticate the data stored in the Data and/or OTP zones.
2. A subsequent Read or Write command can use the digest to provide authentication and/or confidentiality for the data, in which case, it is known as a data protection digest.
3. The command can be used for secure personalization by using a value from the transport key array. The resulting data protection digest would, then, be used by write.
4. The input value, typically a nonce from a remote device, is combined with the current TempKey value to create a shared nonce in which both devices can attest to the inclusion of the RNG.

### 5.3.4 KDF Command

For the ATECC608B-TNGTLS, the KDF command implements several Key Derivation Functions including PRF for TLS 1.2, HKDF for TLS 1.3 and AES. Support for this function is available in CryptoAuthLib. See Section 6.2.3. [CryptoAuthLib](#) for more information.

For additional information on the KDF command contact Microchip Sales for more information.

### 5.3.5 MAC Command

The Message Authentication Code (MAC) command is used to generate a SHA-256 digest of a message, which consists of a key stored in the device, a challenge and other information on the device. The output of this command is the digest of this message.

The normal flow to use this command is as follows:

1. Run the `Nonce` command to load the input challenge and optionally combine it with a generated random number. The result of this operation is a nonce stored internally on the device.
2. Optionally, run the `GenDig` command one or more times to combine stored EEPROM locations in the device with the nonce. The result is stored internally in the device. This capability permits two or more keys to be used as part of the response generation.
3. Run this `MAC` command to combine the output of Step 1 (and Step 2, if desired) with an EEPROM key to generate an output response (i.e., digest).

Alternatively, data in any slot (which does not have to be secret) can be accumulated into the response through the same `GenDig` mechanism. This has the effect of authenticating the value stored in that location.

## 6. Application Information

The ATECC608B-TNGTLS is a member of the Microchip's Trust&GO CryptoAuthentication™ family of products. The Trust&GO products are easy to use, simple to implement and allow even low volume customers to implement security into their end system while leveraging Microchip's expertise and infrastructure in secure provisioning.

The ATECC608B-TNGTLS device has been developed to take the guesswork out of adding security to an IoT- connected product. The product has been pre-configured to readily connect to the IoT Cloud through TLS connections.

In addition to the actual security device, Microchip has developed a series of tools that seamlessly integrate with our hardware devices to provide an easy path to develop your entire security solution. When the developers use Microchip's software security tools, they eliminate the complexity of setting up their own infrastructure and provide a rapid path to initial prototypes and production.

### 6.1 Use Cases

The ATECC608B-TNGTLS has been defined to specifically address the IoT market. Through a single set of certificates, the device has been set to directly support the Google IoT Cloud™, Amazon Web Services (AWS®) and the Microsoft® Azure Cloud. For other IoT networks or for any Public Key Infrastructure (PKI), custom certificates may be required and the customer should consider using Microchip's TrustFLEX family of devices. A brief description of the primary use case for this device is provided below.

#### Secure TLS Connection

The ATECC608B-TNGTLS allows the creation of secure TLS connections using a variety of protocols. The device is capable of establishing secure connections to the Google Cloud, to AWS and other cloud providers. Through the various modes of the Key Derivation Function (KDF), appropriate keys can be generated to support TLS1.2, TLS1.3 and earlier secure connection internet protocols.

### 6.2 Development Tools

The ATECC608B-TNGTLS is supported with multiple hardware and software tools and backend services that provide a path to rapidly develop applications. Initial development can start by using a family of easy-to-use Trust Platform Design Suite tools. These tools provide a graphical way to implement your use case and end with the C code necessary to implement your application.

If your application differs from what the predefined Trust Platform Design Suite tools can provide, then through use of the CryptoAuthLib or the Python® version of CryptoAuthLib and CryptoAuthTools, an application can be developed. CryptoAuthLib is also the backbone of the code that is output from the Trust Platform Design Suite tools.

Full verification of your application can be implemented via hardware tools along with samples of the ATECC608B-TNGTLS device. The access policies of the device are already set, therefore, the focus revolves just around developing the system level code.

Once the application is complete, the ATECC608B-TNGTLS devices can be ordered through Microchip Direct.

#### 6.2.1 Trust Platform Design Suite

To simplify the implementation process, Microchip developed a web-based Trust Platform Design Suite of tools that will allow developers to go from concept to production via a guided flow. The tools allow you to develop and construct the transaction diagrams and code necessary to implement a particular application within the constraints of the configuration and defined access policies of the ATECC608B-TNGTLS.

**Note:** More information on these tools can be found on Microchip's [Trust Platform](#) information page.

### 6.2.2 Hardware Tools

There are multiple hardware tools that can help in developing with the ATECC608B-TNGTLS. Check the Microchip website for the availability of additional tools that are not mentioned here. Specific tools are also mentioned with the specific use case examples.

#### DM320118 - CryptoAuthentication Trust Platform

The [DM320118](#) is a compact development system consisting of an ATSAM21 microcontroller, 1-each of the ATECC608B-TNGTLS, ATECC608B-TFLXTLS and ATECC608B-TCSTM Trust devices, a USB Hub, a mikroBUS connector and an on-board debugger. The kit is intended for use with the Trust Platform Design Suite of tools used to implement various use cases for the ATECC608B-TFLXTLS devices. The kit can be used with either MPLABX or Atmel Studio Design environments to develop additional applications.

#### DT100104 - ATECC608B TRUST

The [DT100104](#) is a mikroBUS™ extension board that contains 1 - ATECC608B-TNGTLS, 3 - ATECC608B-TFLXTLS and 4 - ATECC608B-TCSM device. These boards can be used in lieu of loose sample devices. Each device on the board is individually selected through onboard DIP switches. The board can be directly connected to a DM320118 or any host board that supports a mikroBUS host interface.

#### DM320109 - CryptoAuthentication Starter Kit

The [DM320109](#) consists of an ATSAM21-XPRO development board pre-programmed with firmware that can work with CryptoAuthentication Devices. The kit comes with the AT88CKSCKTISOIC-XPRO socket board but you will need to obtain the UDFN version of the board to work with the sample devices which are currently provided only in the UDFN package. Specific samples of the ATECC608B-TNGTLS will need to be obtained separately.

#### AT88CKSCKTUDFN(SOIC)-XPRO

The [AT88CKSCKTUDFN-XPRO](#) and [AT88CKSCKTISOIC-XPRO](#) are generic CryptoAuthentication socket kits that can be used with any Microcontroller development board with an XPRO interface. Specific samples of the ATECC608B-TNGTLS must be acquired to be used with these kits.

### 6.2.3 CryptoAuthLib

CryptoAuthLib is a software library that supports Microchip’s family of CryptoAuthentication devices. Microchip recommends working with this library when developing with the ATECC608B-TNGTLS. The library implements the API calls necessary to execute the commands detailed in this data sheet.

The library was implemented to readily work with many of Microchip’s microcontrollers but can easily be extended through a Hardware Abstraction Layer (HAL) to other microcontrollers, including those made by other vendors.

For more details on these tools, check the information on:

- [CryptoAuthLib – Web Link](#)
- [CryptoAuthLib – GitHub](#)

#### API Calls

Each of the commands in the data sheet have one or more API calls that are associated with them. Typically, there is a base API call of the command where all input parameters can be specified. The parameter shown in the commands and subsections can be used with this command. There are also mode variants of each of the API calls. The table below shows examples of commands and base API calls. For the most accurate API information, refer to the GitHub information.

**Table 6-1. Example Commands to CryptoAuthLib API Calls**

Device Command	API Call	Comments
Info	atcab_info_base()	
Write	atcab_write()	
Read	atcab_read_zone()	

.....continued		
Device Command	API Call	Comments
SHA	atcab_sha_base()	
Sign	atcab_sign_base()	
Random	atcab_random()	
Verify	atcab_verify()	

### 6.3 TrustFLEX vs. Trust&GO

Trust&GO products have been defined for customers with low volumes that can use a secure off-the-shelf solution. The product's simple onboarding procedure leverages Microchip's secure manufacturing solution and infrastructure. By using this flow, customers do not have to create their own secure manufacturing environment.

However, at times customers may want to have more control over their security environment while still enjoying the simplicity of the Trust&GO product use. The TrustFLEX product was created for these customers. TrustFLEX products are still capable of implementing the use cases of the Trust&GO product but provide additional flexibility for some of the security keys and certificates.

- Same locked configuration as that of the Trust&GO product.
- Same data slot definition as that of the Trust&GO.
- Ability to provision the customer's public key into the device for Secure Boot implementation.
- Ability to do Symmetric Key Authentication. Customers can securely provide their desired Symmetric Keys as part of the secure provisioning process.
- Ability to customize certificate elements and link the certificate chain to the customer's desired PKI.
- Option for either I<sup>2</sup>C or SWI interface devices.

For more information on TrustFLEX products and other provisioning options, see the Microchip [CryptoAuthentication](#) webpages.



## 7. I<sup>2</sup>C Interface

The I<sup>2</sup>C interface uses the SDA and SCL pins to indicate various I/O states to the ATECC608B-TNGTLS. This interface is designed to be compatible at the protocol level with the Microchip AT24C16 Serial EEPROM operating at 1 MHz.

**Note:** There are many differences between the two devices (for example, the ATECC608B-TNGTLS and AT24C16 have different default I<sup>2</sup>C addresses); therefore, designers must read the respective data sheets carefully.

The SDA pin is normally pulled high with an external pull-up resistor because the ATECC608B-TNGTLS client includes only an open-drain driver on its output pin. The bus host may either be open-drain or totem pole. In the latter case, it must be tri-stated when the ATECC608B-TNGTLS is driving results on the bus. The SCL pin is an input and must be driven both high and low at all times by an external device or resistor.



**Remember:** The I<sup>2</sup>C standard uses the terminology “Master” and “Slave”. The equivalent Microchip terminology used in this document is “Host” and “Client”, respectively.

### 7.1 I/O Conditions

The device responds to the following I/O conditions:

#### 7.1.1 Device is Asleep

When the device is asleep, it ignores all but the Wake condition.

- Wake – Upon the rising edge of SDA, after SDA is held low for a period  $\geq t_{WLO}$ , the device exits the Low-Power mode. After a delay of  $t_{WHI}$ , it will be ready to receive I<sup>2</sup>C commands.
- The device ignores any levels or transitions on the SCL pin when the device is idle or asleep and during  $t_{WLO}$ . At some point during  $t_{WHI}$ , the SCL pin is enabled and the conditions listed in 7.1.2. [Device is Awake](#) are honored.

The Wake condition requires that either the system processor manually drive the SDA pin low for  $t_{WLO}$ , or a data byte of 0x00 be transmitted at a clock rate sufficiently slow so that SDA is low for a minimum period of  $t_{WLO}$ . When the device is awake, the normal processor I<sup>2</sup>C hardware and/or software can be used for device communications. This includes the I/O sequences required to put the device back into Low-Power (i.e., Sleep) mode.



**Tip:** A simple way to generate a wake pulse is to send a byte of 0x00 at 100 kHz. Subsequent commands can be run at a higher frequency.

In the I<sup>2</sup>C mode, the device will ignore a wake sequence that is sent when the device is already awake.

#### Multiple Devices on the Bus

When there are multiple devices on the bus and the I<sup>2</sup>C interface is run at speeds of less than  $\sim 300$  kHz<sup>1</sup>, the transmission of certain data patterns will cause the ATECC608B-TNGTLS devices on the bus to wake up. The lower the frequency, the higher the probability that the device wakes up. Because subsequent device addresses transmitted along the bus only match the desired devices, the ATECC608B-TNGTLS will not respond but will be awake. It is recommended that after communicating with another device at slow frequencies, a sleep or idle sequence be issued to place the ATECC608B-TNGTLS back into a known state.

<sup>1</sup> The actual frequency for a given device will vary with process and environmental factors. This value is considered safe under all conditions.



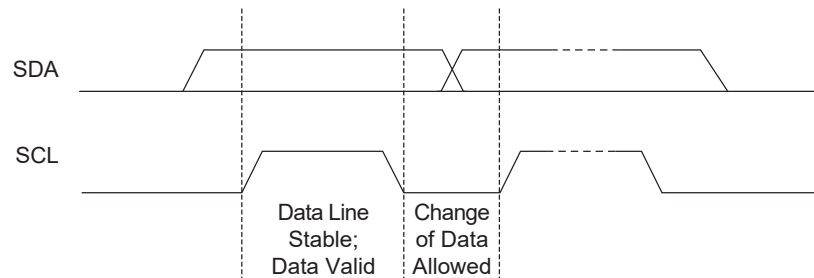
**Important:**  $t_{WLO}$  is the minimum time that the system must provide to ensure that the ATECC608B-TNGTLS will wake under all manufacturing and environmental conditions. In actuality, the device may wake up with a lesser pulse width.

### 7.1.2 Device is Awake

When the device is awake, it honors the conditions listed below:

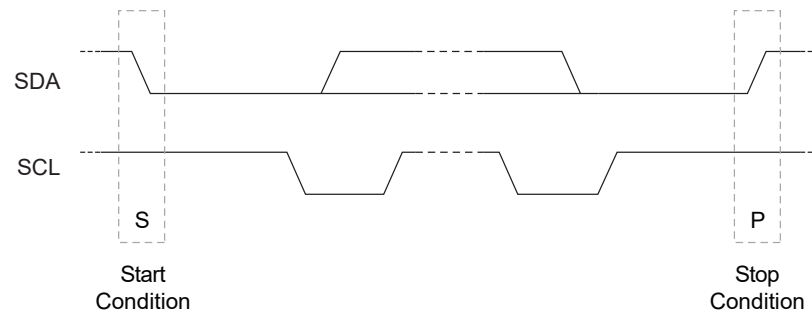
- **DATA Zero:** If SDA is low and stable while SCL goes from low to high to low, then a zero bit is being transferred on the bus. SDA can change while SCL is low.
- **DATA One:** If SDA is high and stable while SCL goes from low to high to low, then a one bit is being transferred on the bus. SDA can change while SCL is low.

**Figure 7-1. Data Bit Transfer on I<sup>2</sup>C Interface**



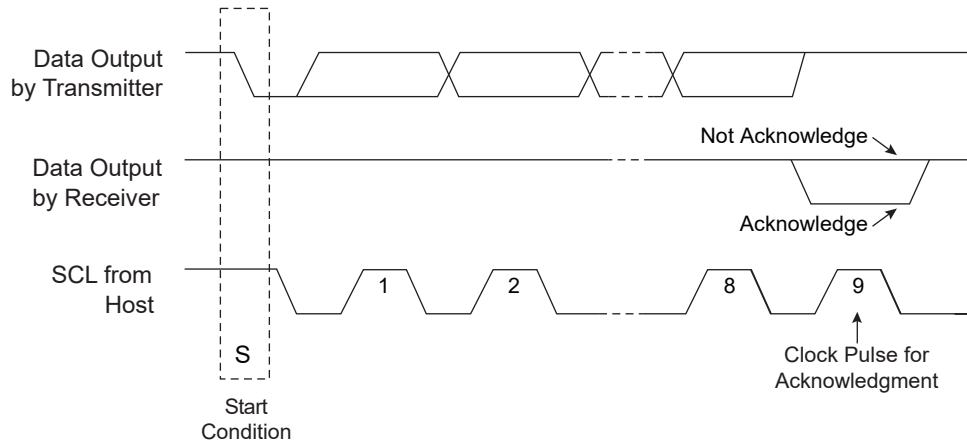
- **Start Condition:** A high-to-low transition of SDA with SCL high is a Start condition which must precede all commands.
- **Stop Condition:** A low-to-high transition of SDA with SCL high is a Stop condition. After this condition is received by the device, the current I/O transaction ends. On input, if the device has sufficient bytes to execute a command, the device transitions to the busy state and begins execution. The Stop condition must always be sent at the end of any packet sent to the device.

**Figure 7-2. Start and Stop Conditions on I<sup>2</sup>C Interface**



- **Acknowledge (ACK):** On the ninth clock cycle after every address or data byte is transferred, the receiver will pull the SDA pin low to acknowledge proper reception of the byte.
- **Not Acknowledge (NACK):** Alternatively, on the ninth clock cycle after every address or data byte is transferred, the receiver can leave the SDA pin high to indicate that there was a problem with the reception of the byte or that this byte completes the group transfer.

Figure 7-3. NACK and ACK Conditions on I<sup>2</sup>C Interface



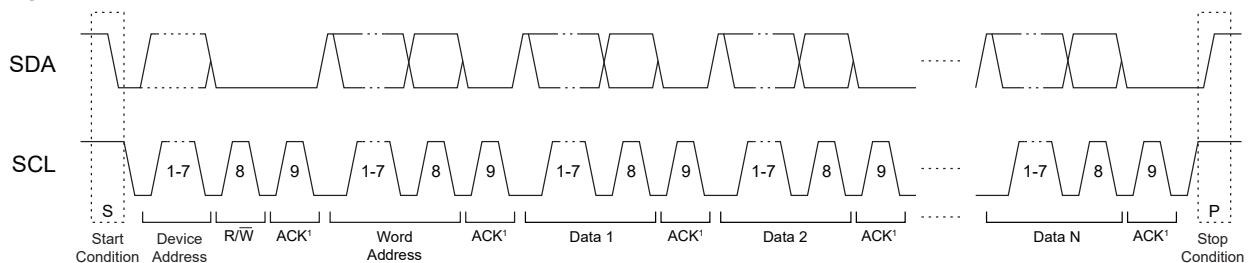
Multiple ATECC608B-TNGTLS devices can easily share the same I<sup>2</sup>C interface signals if the I2C\_Address byte in the Configuration zone is programmed differently for each device on the bus. Because all seven of the bits of the device address are programmable, ATECC608B-TNGTLS can also share the I<sup>2</sup>C interface with any I<sup>2</sup>C device, including any Serial EEPROM.

## 7.2 I<sup>2</sup>C Transmission to ATECC608B-TNGTLS

The transmission of data from the system to the ATECC608B-TNGTLS is summarized in the table below. The order of transmission is as follows:

- Start Condition
- Device Address Byte
- Word Address Byte
- Optional Data Bytes (1 through N)
- Stop Condition

Figure 7-4. Normal I<sup>2</sup>C Transmission to ATECC608B-TNGTLS



SDA is driven low by the ATECC608B-TNGTLS ACK periods.

The following tables label the bytes of the I/O transaction. The column labeled “I<sup>2</sup>C Name” provides the name of the byte as described in the AT24C16 data sheet.

Table 7-1. I<sup>2</sup>C Transmission to ATECC608B-TNGTLS

Name	I <sup>2</sup> C Name	Description
Device Address	Device Address	This byte selects a particular device on the I <sup>2</sup> C interface. The ATECC608B-TNGTLS is selected if bits 1 through 7 of this byte match bits 1 through 7 of the I2C_Address byte in the Configuration zone. Bit 0 of this byte is the standard I <sup>2</sup> C R/W bit and must be zero to indicate a write operation (the bytes following the device address travel from the host to the client).
Word Address	Word Address	This byte must have a value of 0x03 for normal operation.

.....continued		
Name	I <sup>2</sup> C Name	Description
Command	Data1, N	The command group, consisting of the count, command packet and the 2-byte CRC. The CRC is calculated over the size and packet bytes.

Because the device treats the command input buffer as a FIFO, the input group can be sent to the device in one or many I<sup>2</sup>C command groups. The first byte sent to the device is the count, so after the device receives that number of bytes, it will ignore any subsequently received bytes until the execution is finished.

The system must send a Stop condition after the last command byte to ensure that ATECC608B-TNGTLS will start the computation of the command. Failure to send a Stop condition may eventually result in a loss of synchronization; see 7.2.2. I2C Synchronization for recovery procedures.

### 7.2.1 Word Address Values

During an I<sup>2</sup>C write packet, the ATECC608B-TNGTLS interprets the second byte sent as the word address, which indicates the packet function as it is described in the table below:

**Table 7-2. Word Address Values**

Name	Value	Description
Reset	0x00	Resets the address counter. The next I <sup>2</sup> C read or write transaction will start with the beginning of the I/O buffer.
Sleep (Low-power)	0x01	The ATECC608B-TNGTLS goes into the low-power Sleep mode and ignores all subsequent I/O transitions until the next Wake flag. The entire volatile state of the device is reset.
Idle	0x02	The ATECC608B-TNGTLS goes into Idle mode and ignores all subsequent I/O transitions until the next Wake flag. The contents of TempKey, MessageDigestBuffer and Alternate Key registers are retained.
Command	0x03	Writes subsequent bytes to sequential addresses in the input command buffer that follow previous writes. This is the normal operation.
Reserved	0x04 – 0xFF	These addresses must not be sent to the device.

### 7.2.2 I<sup>2</sup>C Synchronization

It is possible for the system to lose synchronization with the I/O port on the ATECC608B-TNGTLS, perhaps due to a system Reset, I/O noise or other conditions. Under this circumstance, the ATECC608B-TNGTLS may not respond as expected, may be asleep or may be transmitting data during an interval when the system is expecting to send data. To resynchronize, the following procedure can be followed:

- To ensure an I/O channel Reset, the system must send the standard I<sup>2</sup>C software Reset sequence as follows:
  - A Start bit condition
  - Nine cycles of SCL, with SDA held high by the system pull-up resistor
  - Another Start bit condition
  - A Stop bit condition

It may, then, be possible to send a read sequence, and if synchronization completes properly, the ATECC608B-TNGTLS will ACK the device address. The device may return data or may leave the bus floating (which the system will interpret as a data value of 0xFF) during the data periods.

If the device does ACK the device address, the system must reset the internal address counter to force the ATECC608B-TNGTLS to ignore any partial input command that may have been sent. This can be accomplished by sending a write sequence to word address 0x00 (Reset), followed by a Stop condition.

- If the device does not respond to the device address with an ACK, then it may be asleep. In this case, the system must send a complete Wake token and wait  $t_{WHI}$  after the rising edge. The system may, then, send another read sequence, and if synchronization is complete, the device will ACK the device address.

3. If the device still does not respond to the device address with an ACK, then it may be busy executing a command. The system must wait the longest  $t_{EXEC}$  (max.), then send the read sequence, which will be acknowledged by the device.

### 7.3 Sleep Sequence

Upon completion of the use of the ATECC608B-TNGTLS by the system, it is recommended that the system issue a sleep sequence to put the device into Low-Power mode. This sequence consists of the proper device address followed by the value of 0x01 as the word address followed by a Stop condition. This transition to the Low-Power state causes a complete reset of the device's internal command engine and input/output buffer. It can be sent to the device at any time when it is awake and not busy.

### 7.4 Idle Sequence

If the total sequence of required commands exceeds  $t_{WATCHDOG}$ , then the device will automatically go to sleep and lose any information stored in the volatile registers. This action can be prevented by putting the device into Idle mode prior to completion of the watchdog interval. When the device receives the Wake token, it will then restart the Watchdog Timer and execution can be continued.

The idle sequence consists of the proper device address followed by the value of 0x02 as the word address followed by a Stop condition. It can be sent to the device at any time when it is awake and not busy.

### 7.5 I<sup>2</sup>C Transmission from the ATECC608B-TNGTLS

When the ATECC608B-TNGTLS is awake and not busy, the host can retrieve the current output buffer contents from the device using an I<sup>2</sup>C read. If valid command results are available, the size of the group returned is determined by the particular command that is run. Otherwise, the size of the group (and the first byte returned) will always be four: count, status/error and 2-byte CRC.

**Table 7-3. I<sup>2</sup>C Transmission from the ATECC608B-TNGTLS**

Name	I <sup>2</sup> C Name	Direction	Description
Device Address	Device Address	To Client	This byte selects a particular device on the I <sup>2</sup> C interface and the ATECC608B-TNGTLS will be selected if bits 1 through 7 of this byte match bits 1 through 7 of the I2C_Address byte in the Configuration zone. Bit 0 of this byte is the standard I <sup>2</sup> C R/W pin and must be one to indicate that the bytes following the device address travel from the client to the host (read).
Data	Data1, N	To Host	The output group, consisting of the count, status/error byte or the output packet followed by the 2-byte CRC.

The status, error or command outputs can be read repeatedly by the host. Each time a Read command is sent to the ATECC608B-TNGTLS along the I<sup>2</sup>C interface, the device transmits the next sequential byte in the output buffer. See the following section for details on how the device handles the address counter.

If the ATECC608B-TNGTLS is busy, idle or asleep, it will NACK the device address on a read sequence. If a partial command is sent to the device and a read sequence `[Start + DeviceAddress (R/W == R)]` is sent to the device, the ATECC608B-TNGTLS will NACK the device address to indicate that no data are available to be read.

## 8. Electrical Characteristics

### 8.1 Absolute Maximum Ratings

<b>Operating Temperature</b>	-40°C to +85°C
<b>Storage Temperature</b>	-65°C to +150°C
<b>Maximum Operating Voltage</b>	6.0V
<b>DC Output Current</b>	5.0 mA
<b>Voltage on any pin -0.5V to (V<sub>CC</sub> + 0.5V)</b>	-0.5V to (V <sub>CC</sub> + 0.5V)
<b>ESD Ratings:</b>	
<b>Human Body Model(HBM) ESD</b>	>4 kV
<b>Charge Device Model(CDM) ESD</b>	>1 kV

**Note:** Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### 8.2 Reliability

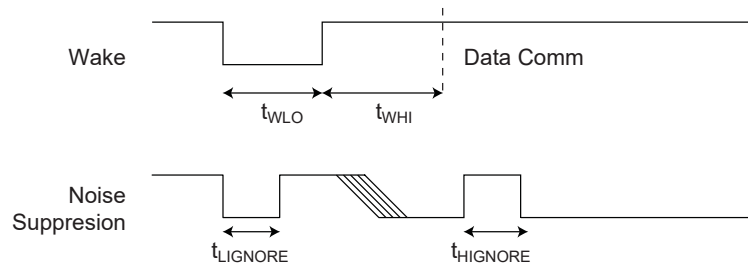
The ATECC608B-TNGTLS is fabricated with Microchip’s high reliability CMOS EEPROM manufacturing technology.

**Table 8-1. EEPROM Reliability**

Parameter	Min.	Typ.	Max.	Units
Write Endurance at +85°C (Each Byte)	400,000	—	—	Write Cycles
Data Retention at +55°C	10	—	—	Years
Data Retention at +35°C	30	50	—	Years
Read Endurance	Unlimited			Read Cycles

### 8.3 AC Parameters: All I/O Interfaces

**Figure 8-1. AC Timing Diagram: All Interfaces**



**Table 8-2. AC Parameters: All I/O Interfaces**

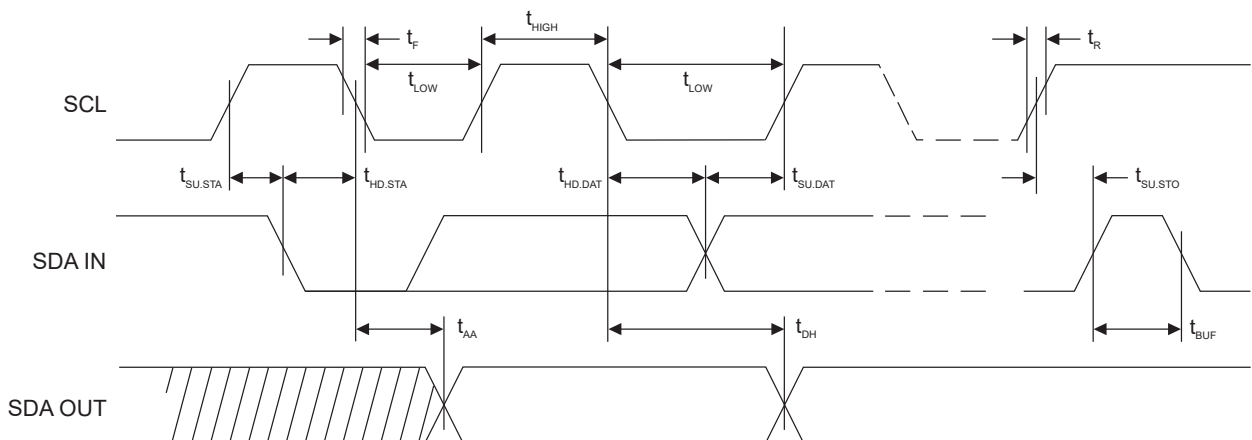
Parameter	Sym.	Direction	Min.	Typ.	Max.	Units	Conditions
Power-Up Delay <sup>2</sup>	$t_{PU}$	To Crypto Device	100	—	—	$\mu$ s	Minimum time between $V_{CC} > V_{CC\ min}$ prior to start of $t_{WLO}$ .
Wake Low Duration	$t_{WLO}$	To Crypto Device	60	—	—	$\mu$ s	—
Wake High Delay to Data Comm	$t_{WHI}$	To Crypto Device	1500	—	—	$\mu$ s	SDA is recommended to be stable high for this entire duration unless polling is implemented. SelfTest is not enabled at power-up.
Wake High Delay when SelfTest is Enabled	$t_{WHIST}$	To Crypto Device	20	—	—	ms	SDA is recommended to be stable high for this entire duration unless polling is implemented.
High-Side Glitch Filter at Active	$t_{HIGNORE\_A}$	To Crypto Device	45 <sup>1</sup>	—	—	ns	Pulses shorter than this in width will be ignored by the device, regardless of its state when active.
Low-Side Glitch Filter at Active	$t_{LIGNORE\_A}$	To Crypto Device	45 <sup>1</sup>	—	—	ns	Pulses shorter than this in width will be ignored by the device, regardless of its state when active.
Low-Side Glitch Filter at Sleep	$t_{LIGNORE\_S}$	To Crypto Device	15 <sup>1</sup>	—	—	$\mu$ s	Pulses shorter than this in width will be ignored by the device when in Sleep mode.
Watchdog Time-out	$t_{WATCHDOG}$	To Crypto Device	0.7	1.3	1.7	s	Time from wake until device is forced into Sleep mode if Config.ChipMode[2] is 0.

**Notes:**

1. These parameters are characterized, but not production tested.
2. The power-up delay will be significantly longer if power-on self test is enabled in the Configuration zone.

### 8.3.1 AC Parameters: I<sup>2</sup>C Interface

**Figure 8-2. I<sup>2</sup>C Synchronous Data Timing**



**Table 8-3. AC Characteristics of I<sup>2</sup>C Interface<sup>(2)</sup>**

Unless otherwise specified, applicable over recommended operating range from  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ ,  $V_{CC} = +2.0V$  to  $+5.5V$ ,  $C_L = 1$  TTL Gate and  $100$  pF.

Parameter	Sym.	Min.	Max.	Units
SCL Clock Frequency	$f_{SCL}$	0	1	MHz
SCL High Time	$t_{HIGH}$	400	—	ns
SCL Low Time	$t_{LOW}$	400	—	ns
Start Setup Time	$t_{SU,STA}$	250	—	ns
Start Hold Time	$t_{HD,STA}$	250	—	ns
Stop Setup Time	$t_{SU,STO}$	250	—	ns
Data In Setup Time	$t_{SU,DAT}$	100	—	ns
Data In Hold Time	$t_{HD,DAT}$	0	—	ns
Input Rise Time <sup>1</sup>	$t_R$	—	300	ns
Input Fall Time <sup>1</sup>	$t_F$	—	100	ns
Clock Low to Data Out Valid	$t_{AA}$	50	550	ns
Data Out Hold Time	$t_{DH}$	50	—	ns
SMBus Time-Out Delay	$t_{TIMEOUT}$	25	35	ms
Time bus must be free before a new transmission can start <sup>1</sup>	$t_{BUF}$	500	—	ns

**Notes:**

- Values are based on characterization and are not tested.
- AC measurement conditions:
  - $R_L$  (connects between SDA and  $V_{CC}$ ): 1.2 k $\Omega$  (for  $V_{CC} = +2.0V$  to  $+5.0V$ )
  - Input pulse voltages:  $0.3V_{CC}$  to  $0.7V_{CC}$
  - Input rise and fall times:  $\leq 50$  ns
  - Input and output timing reference voltage:  $0.5V_{CC}$

**8.4 DC Parameters: All I/O Interfaces****Table 8-4. DC Parameters on All I/O Interfaces**

Parameter	Sym.	Min.	Typ.	Max.	Units	Conditions
Ambient Operating Temperature	$T_A$	-40	—	+85	$^{\circ}C$	Standard Industrial Temperature Range
Power Supply Voltage	$V_{CC}$	2.0	—	5.5	V	—
Active Power Supply Current	$I_{CC}$	—	2	3	mA	Waiting for I/O during I/O transfers or execution of non-ECC commands. Independent of Clock Divider value.
		—	—	14	mA	During ECC command execution. Clock divider = 0x0
Idle Power Supply Current	$I_{IDLE}$	—	800	—	$\mu A$	When device is in Idle mode, $V_{SDA}$ and $V_{SCL} < 0.4V$ or $> V_{CC} - 0.4$
Sleep Current	$I_{SLEEP}$	—	30	150	nA	When device is in Sleep mode, $V_{CC} \leq 3.6V$ , $V_{SDA}$ and $V_{SCL} < 0.4V$ or $> V_{CC} - 0.4$ , $T_A \leq +55^{\circ}C$
		—	—	2	$\mu A$	When device is in Sleep mode. Over full $V_{CC}$ range and $-40^{\circ}C$ to $85^{\circ}C$ temperature range.



.....continued

Parameter	Sym.	Min.	Typ.	Max.	Units	Conditions
Output Low Voltage	$V_{OL}$	—	—	0.4	V	When device is in Active mode, $V_{CC} = 2.5$ to $5.5V$
Output Low Current	$I_{OL}$	—	—	4	mA	When device is in Active mode, $V_{CC} = 2.5$ to $5.5V$ , $V_{OL} = 0.4V$
Theta JA	$\Theta_{JA}$	—	166	—	°C/W	SOIC (SS)
		—	173	—	°C/W	UDFN (MA)

### 8.4.1 $V_{IH}$ and $V_{IL}$ Specifications

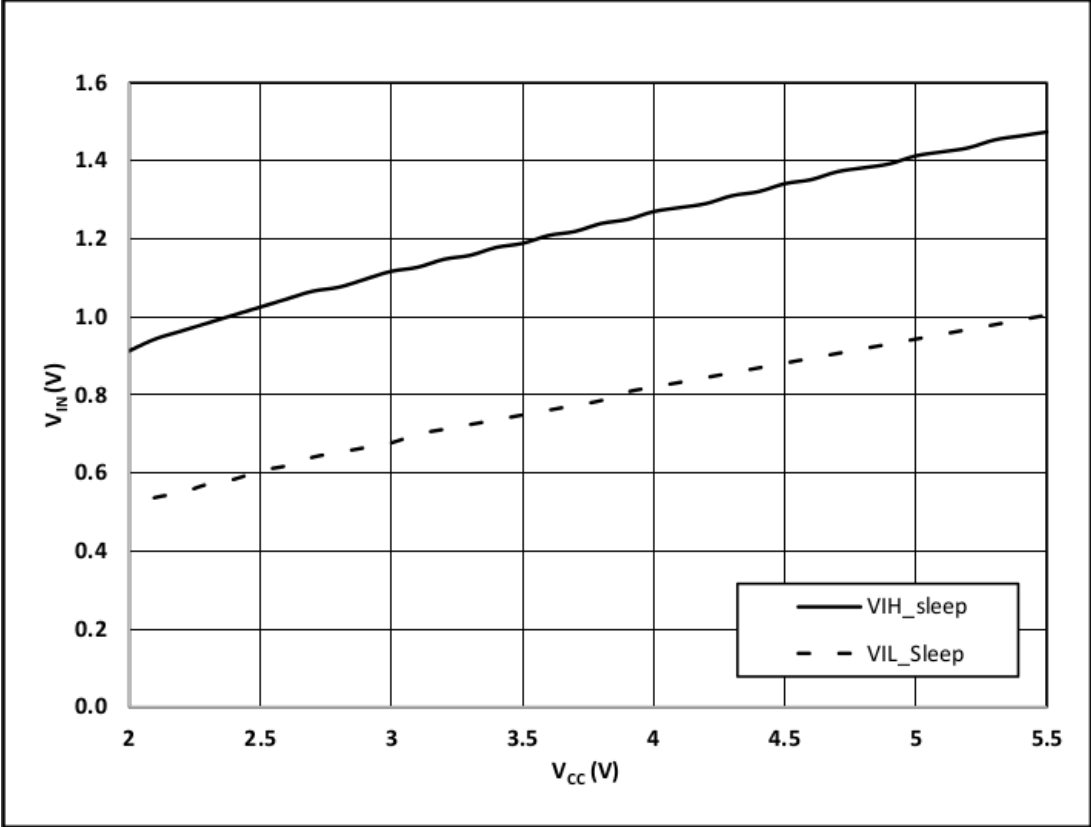
The input levels of the device will vary dependent on the mode and voltage of the device. The input voltage thresholds when in Sleep or Idle mode are dependent on the  $V_{CC}$  level as shown in [Figure 8-3](#). When in Sleep or Idle mode the TTLenable bit has no effect.

The active input levels of the ATECC608B-TNGTLS are fixed and do not vary with the  $V_{CC}$  level. The input levels transmitted to the device must comply with the table below.

**Table 8-5.  $V_{IL}$ ,  $V_{IH}$  on All I/O Interfaces (TTLenable = 0)**

Parameter	Sym.	Min.	Typ.	Max.	Units	Conditions
Input Low Voltage	$V_{IL}$	-0.5	—	0.5	V	When device is active and TTLenable bit in Configuration memory is zero; otherwise, see above.
Input High Voltage	$V_{IH}$	1.5	—	$V_{CC} + 0.5$	V	When device is active and TTLenable bit in Configuration memory is zero; otherwise, see above.

Figure 8-3.  $V_{IH}$  and  $V_{IL}$  in Sleep and Idle Mode



## 9. Compatibility

### ATECC608A-TNGTLS Compatibility

The ATECC608B-TNGTLS provides form, fit and function compatibility to the ATECC608A-TNGTLS device. Device configuration zone and slot configuration values are identical, operating conditions are identical, all commands and command modes are still supported and the 8-Pad UDFN and 8-PIN SOIC packages and pinouts are identical.

If a design was implemented using the Microchip Trust Platform Design Suite, then migration from the ATECC608A-TNGTLS to the ATECC608B-TNGTLS is seamless.

## **10. Package Drawings**

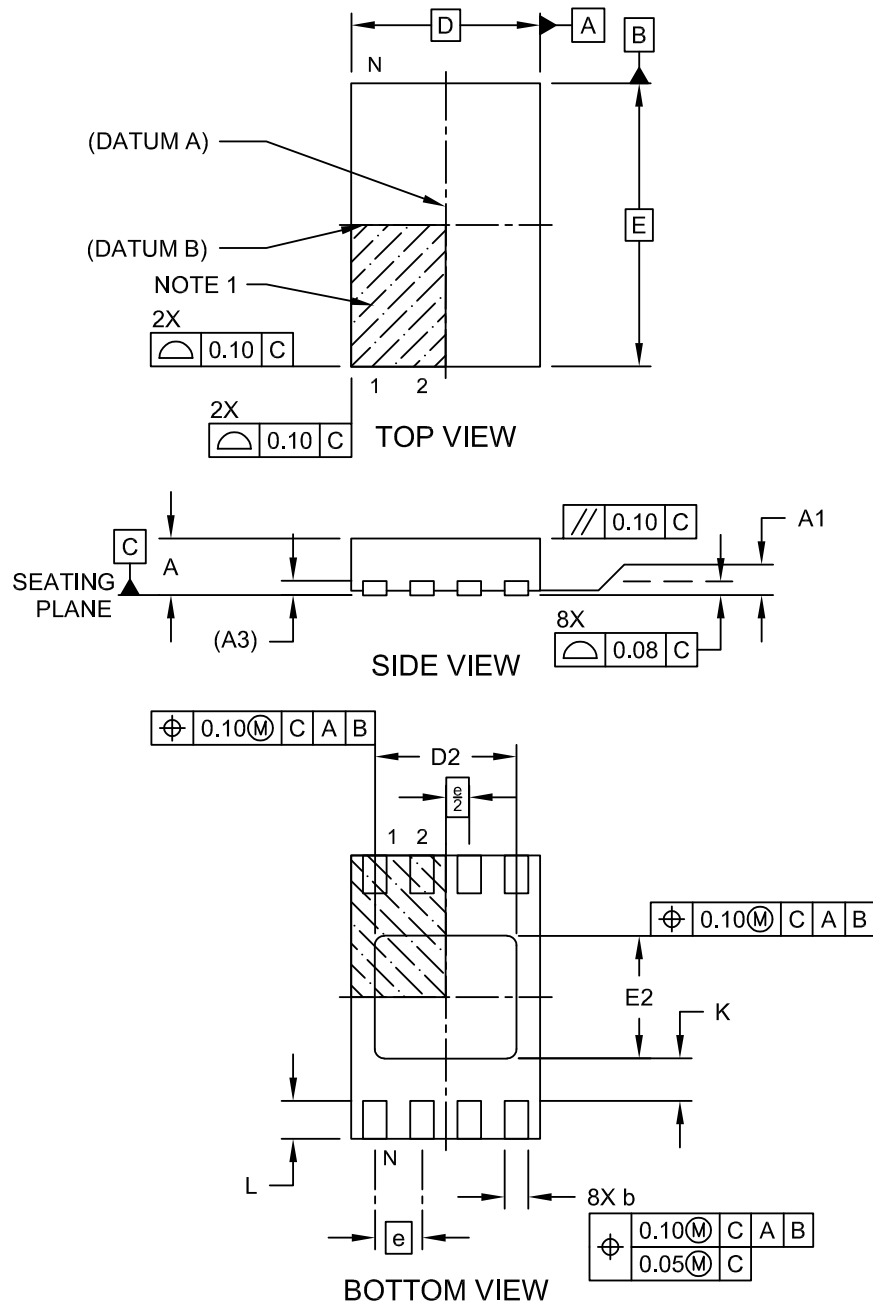
### **10.1 Package Marking Information**

As part of Microchip's overall security features, the part marking for all crypto devices is intentionally vague. The marking on the top of the package does not provide any information as to the actual device type or the manufacturer of the device. The alphanumeric code on the package provides manufacturing information and will vary with assembly lot. It is recommended that the packaging mark not be used as part of any incoming inspection procedure.

**10.2 8-Pad UDFN**

**8-Lead Ultra Thin Plastic Dual Flat, No Lead Package (Q4B) - 2x3 mm Body [UDFN]  
 Atmel Legacy Global Package Code YNZ**

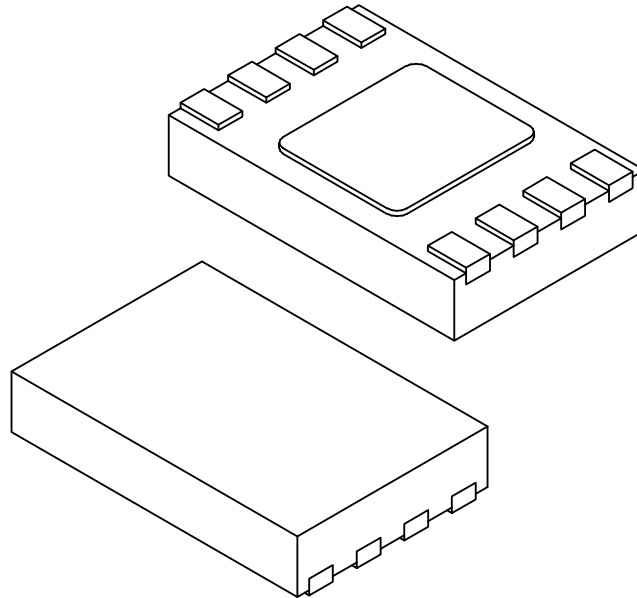
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Microchip Technology Drawing C04-21355-Q4B Rev C Sheet 1 of 2

### 8-Lead Ultra Thin Plastic Dual Flat, No Lead Package (Q4B) - 2x3 mm Body [UDFN] Atmel Legacy Global Package Code YNZ

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Number of Terminals	N	8		
Pitch	e	0.50 BSC		
Overall Height	A	0.50	0.55	0.60
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	A3	0.152 REF		
Overall Length	D	2.00 BSC		
Exposed Pad Length	D2	1.40	1.50	1.60
Overall Width	E	3.00 BSC		
Exposed Pad Width	E2	1.20	1.30	1.40
Terminal Width	b	0.18	0.25	0.30
Terminal Length	L	0.25	0.35	0.45
Terminal-to-Exposed-Pad	K	0.20	-	-

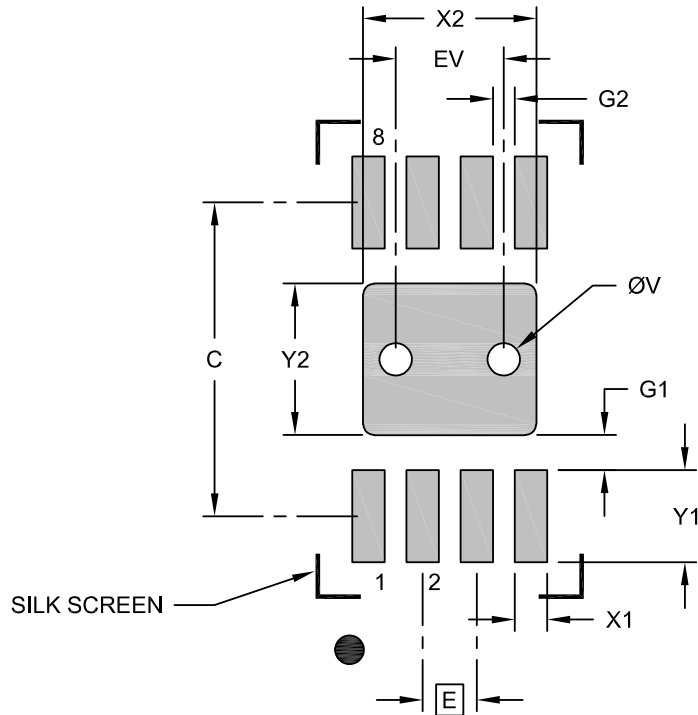
**Notes:**

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated
3. Dimensioning and tolerancing per ASME Y14.5M
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
  - REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-21355-Q4B Rev C Sheet 2 of 2

### 8-Lead Ultra Thin Plastic Dual Flat, No Lead Package (Q4B) - 2x3 mm Body [UDFN] Atmel Legacy Global Package Code YNZ

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



**RECOMMENDED LAND PATTERN**

Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Contact Pitch	E	0,50 BSC		
Optional Center Pad Width	X2			1,60
Optional Center Pad Length	Y2			1,40
Contact Pad Spacing	C		2,90	
Contact Pad Width (X8)	X1			0,30
Contact Pad Length (X8)	Y1			0,85
Contact Pad to Center Pad (X8)	G1	0,33		
Contact Pad to Contact Pad (X6)	G2	0,20		
Thermal Via Diameter	V		0,30	
Thermal Via Pitch	EV		1,00	

**Notes:**

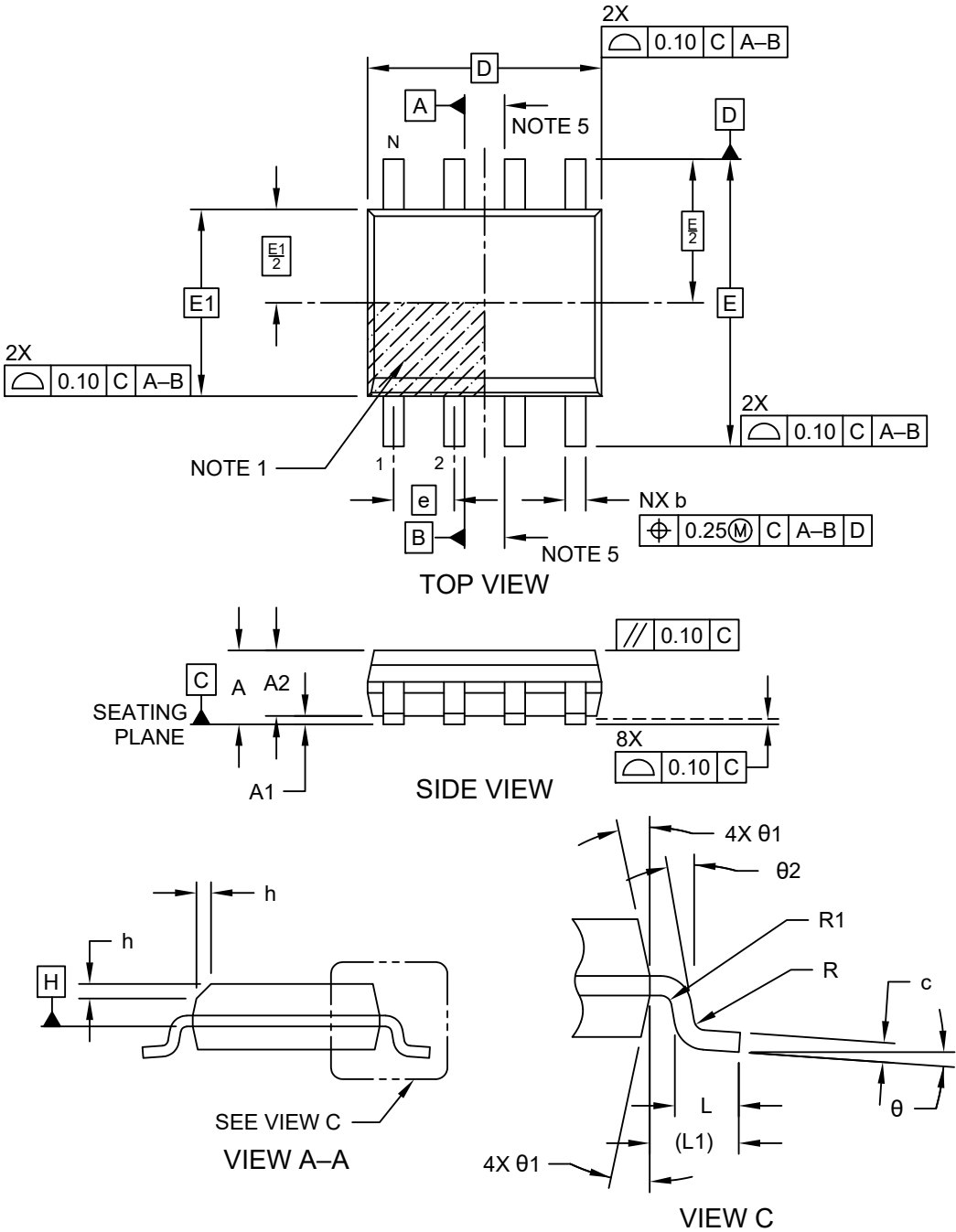
1. Dimensioning and tolerancing per ASME Y14.5M  
BSC: Basic Dimension. Theoretically exact value shown without tolerances.
2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-23355-Q4B Rev C

**10.3 8-Lead SOIC**

**8-Lead Plastic Small Outline (C2X) - Narrow, 3.90 mm (.150 In.) Body [SOIC]  
 Atmel Legacy Global Package Code SWB**

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>

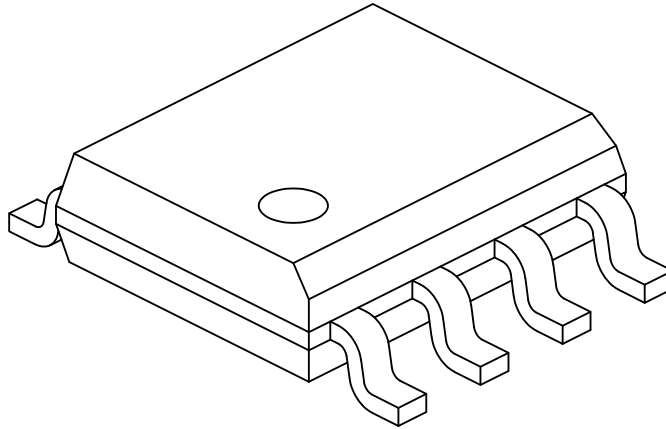


Microchip Technology Drawing No. C04-057-C2X Rev K Sheet 1 of 2



**8-Lead Plastic Small Outline (C2X) - Narrow, 3.90 mm (.150 In.) Body [SOIC]  
Atmel Legacy Global Package Code SWB**

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Number of Pins	N	8		
Pitch	e	1.27 BSC		
Overall Height	A	–	–	1.75
Molded Package Thickness	A2	1.25	–	–
Standoff §	A1	0.10	–	0.25
Overall Width	E	6.00 BSC		
Molded Package Width	E1	3.90 BSC		
Overall Length	D	4.90 BSC		
Chamfer (Optional)	h	0.25	–	0.50
Foot Length	L	0.40	–	1.27
Footprint	L1	1.04 REF		
Lead Thickness	c	0.17	–	0.25
Lead Width	b	0.31	–	0.51
Lead Bend Radius	R	0.07	–	–
Lead Bend Radius	R1	0.07	–	–
Foot Angle	θ	0°	–	8°
Mold Draft Angle	θ1	5°	–	15°
Lead Angle	θ2	0°	–	–

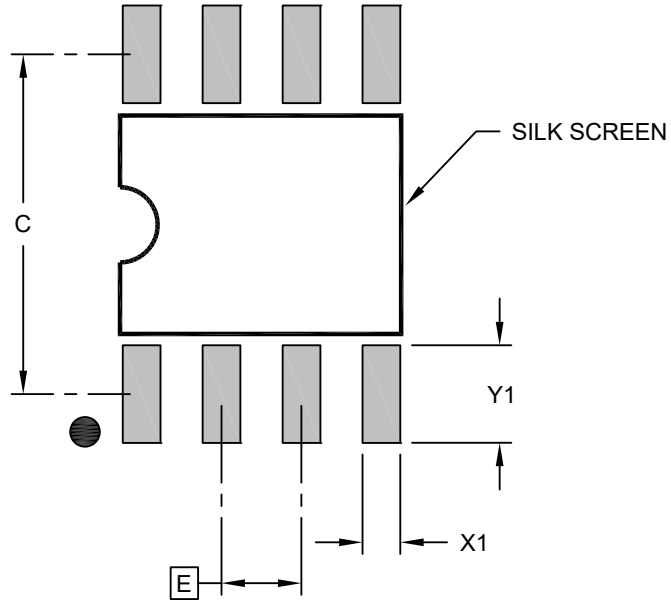
**Notes:**

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.
- Dimensioning and tolerancing per ASME Y14.5M
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
  - REF: Reference Dimension, usually without tolerance, for information purposes only.
- Datums A & B to be determined at Datum H.

Microchip Technology Drawing No. C04-057-C2X Rev K Sheet 2 of 2

### 8-Lead Plastic Small Outline (C2X) - Narrow, 3.90 mm (.150 In.) Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension	Limits	MIN	NOM	MAX
Contact Pitch	E	1.27 BSC		
Contact Pad Spacing	C		5.40	
Contact Pad Width (X8)	X1			0.60
Contact Pad Length (X8)	Y1			1.55

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M  
 BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-2057-C2X Rev K

## 11. Revision History

### Revision B (April 2023)

- [Product Identification System](#) – Changed 2k Reel size to Minimum Order Quantity (MOQ)
- [Use Cases](#) – Renamed Applications section
- [Table 2-2](#) – Added definitions for Least/Most Significant bytes and bits
- [2.2.1.2. Public Keys](#) – Added section
- Removed Terms Master/Slave associated with I<sup>2</sup>C bus in favor of Host/Client
- Reduction in information provided about commands
- [8.3.1. AC Parameters: I2C Interface](#) – Corrected SMBUS Max Timeout  $t_{TIMEOUT}$
- [10.2. 8-Pad UDFN](#) – Updated UDFN Package Diagrams
- [10.3. 8-Lead SOIC](#) – Updated SOIC Package Diagrams

### Revision A (September 2020)

- Original release of the document based on ATECC608A-TNGTLS (DS40002112C)

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## Product Identification System

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PART NO.	X	-X	
Device	Package Type	Tape and Reel	

Device:	ATECC608B-TNGTLS: Pre-configured Cryptographic Co-processor with secure hardware-based key storage for the IoT market.	
Package Options	U	8-Pad 2 x 3 x 0.6 mm Body, Thermally Enhanced Plastic Ultra Thin Dual Flat No Lead Package (UDFN)
	S	8-Lead (0.150" Wide Body), Plastic Gull Wing Small Outline (JEDEC SOIC)
Tape and Reel Options <sup>(1)</sup>	G	Reel size will vary <sup>(2)</sup> 2k Minimum Order Quantity (MOQ) is required.
	C	100 Unit Reel <sup>(3)</sup>
	B	10 Unit Bulk- Prototype units

**Examples:**

- ATECC608B-TNGTLSU-G: Trust&GO TLS, Provisioned, 8-UDFN, I<sup>2</sup>C, 2K MOQ
- ATECC608B-TNGTLSU-C: Trust&GO TLS, Provisioned, 8-UDFN, I<sup>2</sup>C, 100 Unit Reel
- ATECC608B-TNGTLSU-B: Trust&GO TLS, Proto Typing, 8-UDFN, I<sup>2</sup>C, 10 Unit Bulk
- ATECC608B-TNGTLSS-G: Trust&GO TLS, Provisioned, 8-SOIC, I<sup>2</sup>C, 2K MOQ
- ATECC608B-TNGTLSS-C: Trust&GO TLS, Provisioned, 8-SOIC, I<sup>2</sup>C, 100 Unit Reel
- ATECC608B-TNGTLSS-B: Trust&GO TLS, Proto Typing, 8-SOIC, I<sup>2</sup>C, 10 Unit Bulk

**Notes:**

1. Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.
2. Production reel size will vary based on the size of the order, but the minimum order quantity for production is 2k units.
3. Small unit volumes can be ordered in quantities of 100 units per reel. No fractional orders are permitted at this reel size.

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ISBN\_VAR: xxx-x-xxxxx-xxx-x

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